

Analyzing & Testing

NETZSCH

Proven Excellence.

CURING KINETICS:
Measurements, Models, Kinetics analysis
and process optimization by Kinetics Neo

Elena Moukhina
Webinar, February, 18 2025

-
1. Kinetics for thermosets, composites, photopolymers:
Introduction and Workflow
 2. Thermal analysis methods for study of curing process:
Properties and methods
 3. Kinetic models for curing process, dependence on time and temperature
Kinetic approached, models, autocatalysis, diffusion control
 4. Time-Temperature-Transformation diagram, including gelation and vitrification
Construction and Validation
 5. Dependence of curing on additional parameter
 1. UV intensity
 2. Concentrations
 6. Simulation of curing process in thick layers depending on thickness and surrounding. Termica Neo software

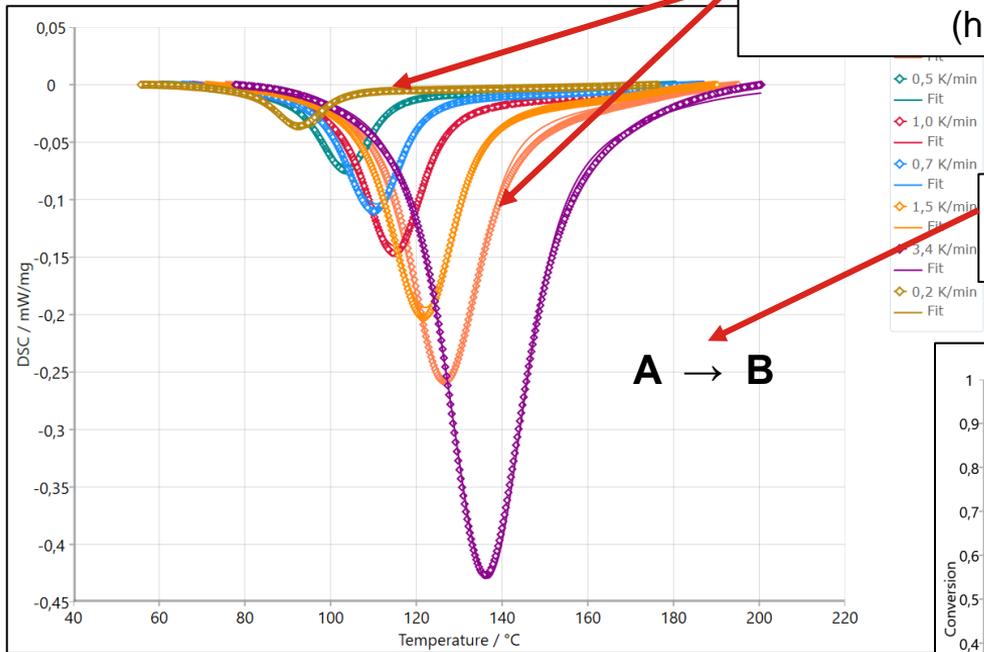
1

Kinetics for Thermosets, composites, photopolymers

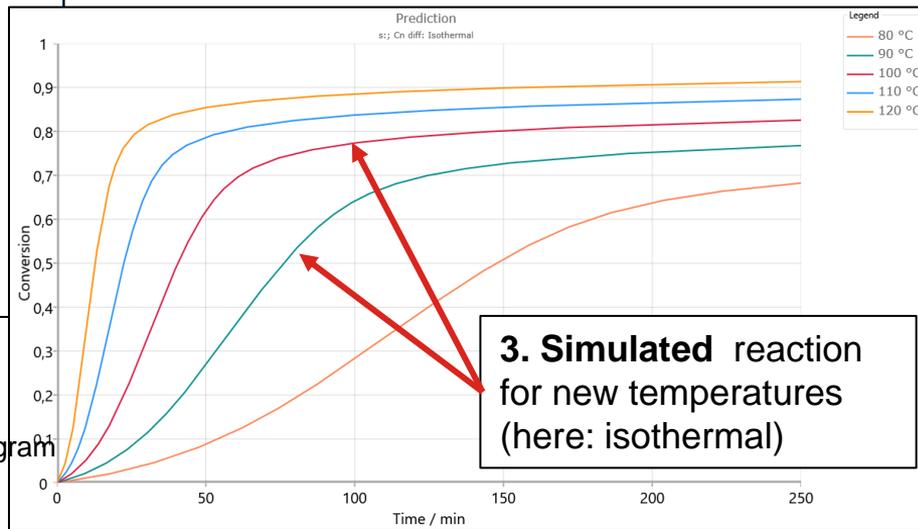


Idea: How to solve the problems

1. Measured data for the process at different temperature conditions (here: heating for epoxy resin)



2. Kinetic Model for the chemical reaction
Simulated curves must fit experimental data



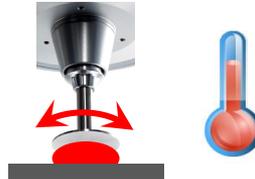
3. Simulated reaction for new temperatures (here: isothermal)

Kinetic analysis helps to

- **Find** and describe the kinetic **mechanism of chemical reaction**
- **Predict** degree of conversion and reaction rate for given temperature program
- **Optimize** industrial processes: decrease production time and costs and improve the quality of product

2

Thermal analysis methods for curing process



Dielectric analysis



Properties:

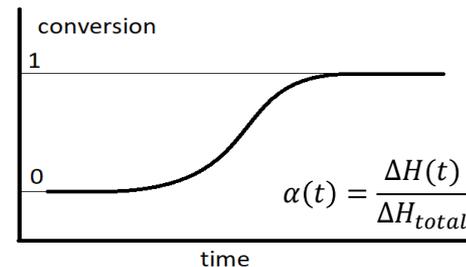
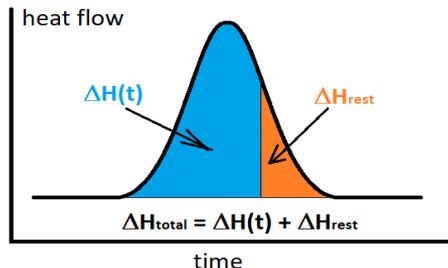
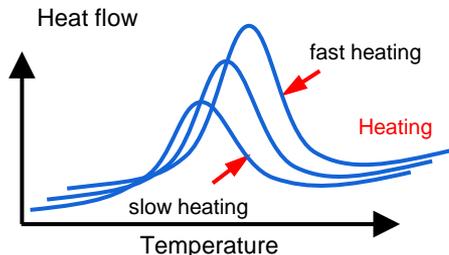
- Enthalpy of reaction
- Gel point,
- Glass transition temperature,
- Heat capacity
- Viscosity

Methods:

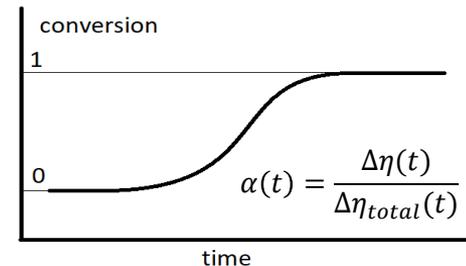
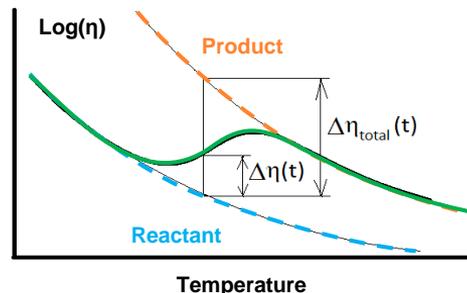
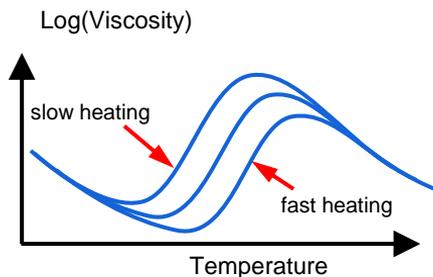
- DSC,
- TM-DSC,
- rheology,
- dielectric analysis

Main data for kinetic analysis of curing systems: heat flow, shear viscosity, ion viscosity

DSC

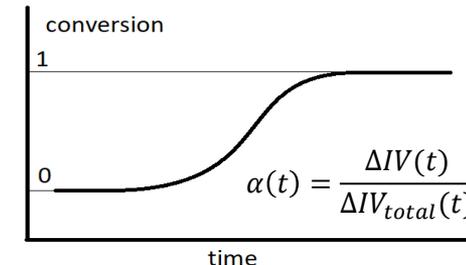
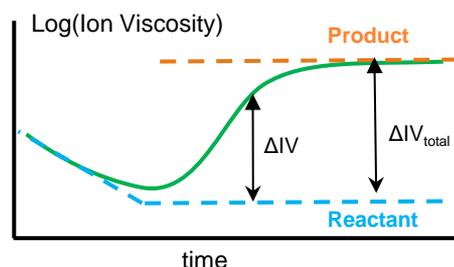
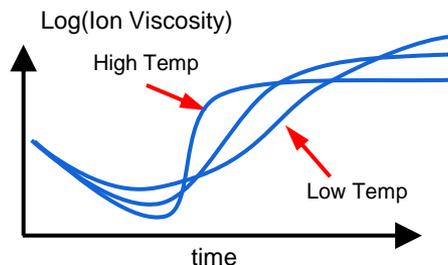


Rheology



DEA

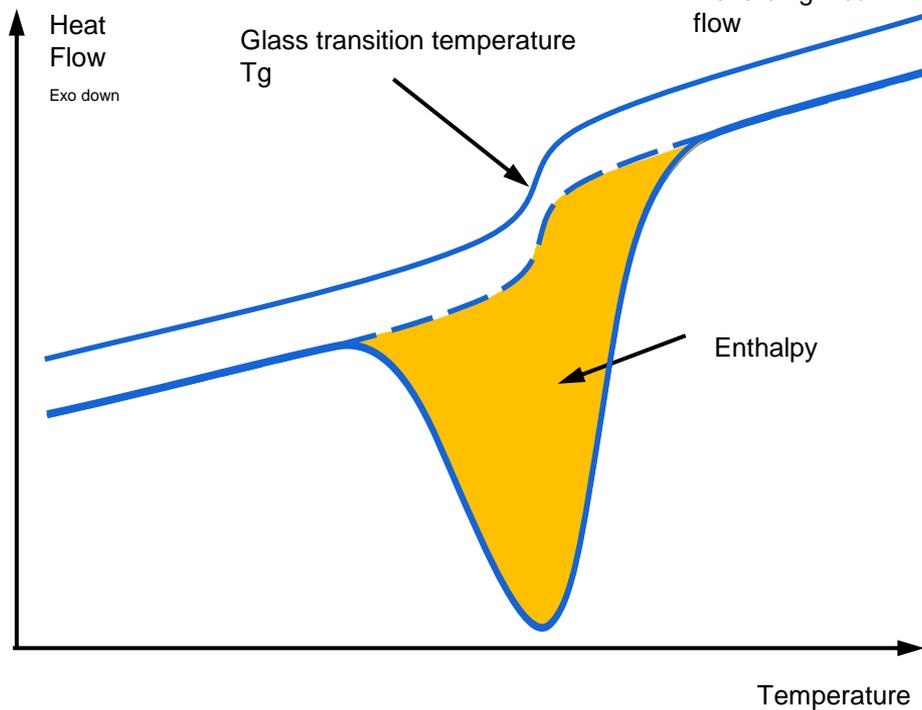
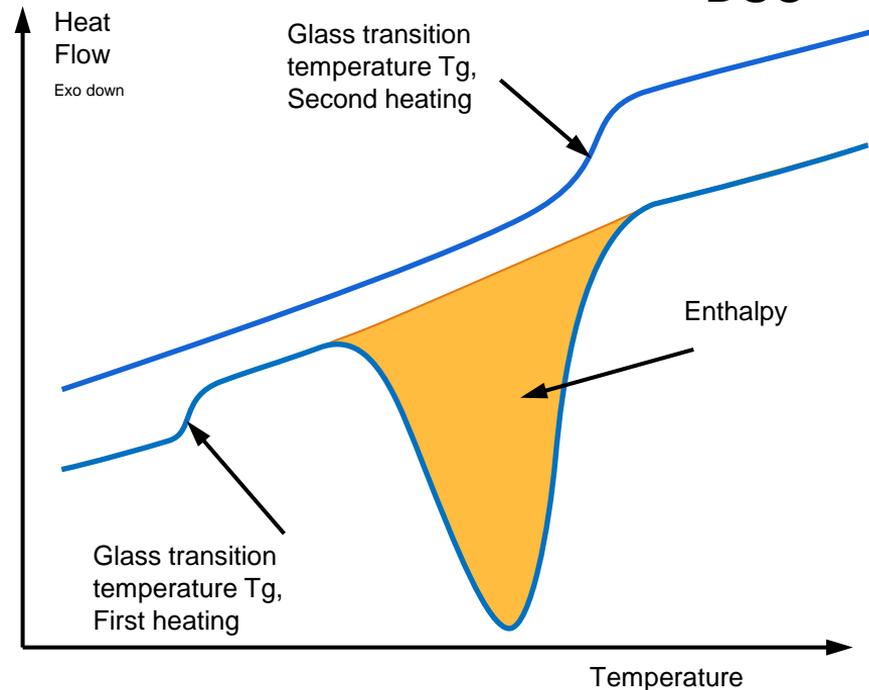
Dielectric analysis

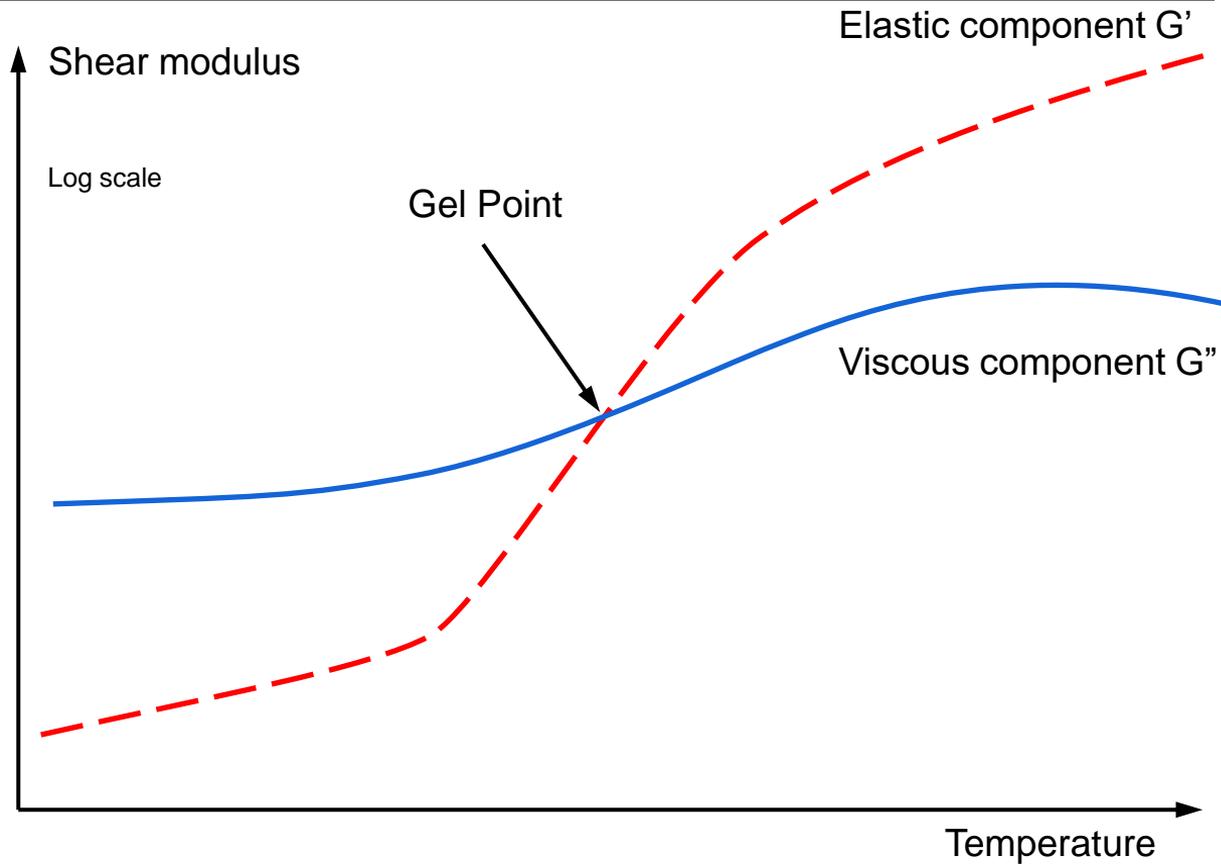


Temperature conditions: heating with different heating rates or isothermal at different temperatures

DSC

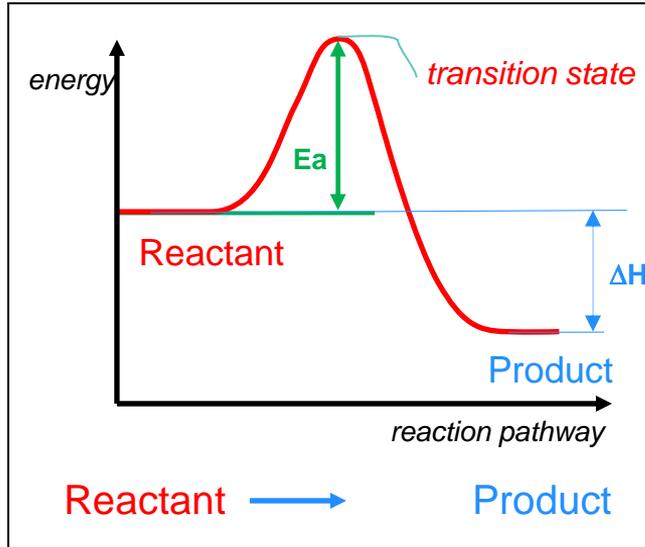
TM-DSC





3

Kinetic models for curing process,
dependence on time and temperature



Arrhenius equation (1889) for reaction rate:

$$\frac{d\alpha}{dt} = A \exp\left(\frac{-E_A}{RT}\right) f(\alpha)$$

Conversion α : degree of conversion, changing from 0 to 1

Pre-exponent A : collision frequency [1/s]

Activation energy E_a [kJ/mol]

$f(\alpha)$ Reaction type (nth order, autocatalysis, nucleation ...)

Model free approach:

1. Only **one** kinetic equation
2. E_a and A **depend on α**

Model based approach:

1. **Each step has own** kinetic equation
2. E_a and A are independent from α

Kinetic Modelling for Curing

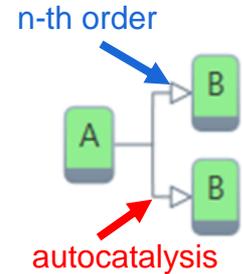
Chemical process is **generally** described by Arrhenius equation:

$$\frac{d\alpha}{dt} = A \cdot f(\alpha) \cdot \exp\left(\frac{-Ea}{RT}\right)$$



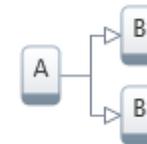
Curing can be described by the equation **Kamal-Sourour** for autocatalytic reaction:

$$\frac{d\alpha}{dt} = \underbrace{A \cdot (1 - \alpha)^n \cdot \exp\left(\frac{-E_{a1}}{RT}\right)}_{\text{n-th order}} + \underbrace{A \cdot K \cdot (1 - \alpha)^n \cdot \alpha^m \cdot \exp\left(\frac{-E_{a2}}{RT}\right)}_{\text{autocatalysis}}$$



C_{mn} – reaction of the n^{th} order with autocatalysis of m^{th} order by product

$$\frac{d\alpha}{dt} = A \cdot (1 - \alpha)^n \cdot \exp\left(\frac{-E_{a1}}{RT}\right) (1 + K \cdot \alpha^m)$$



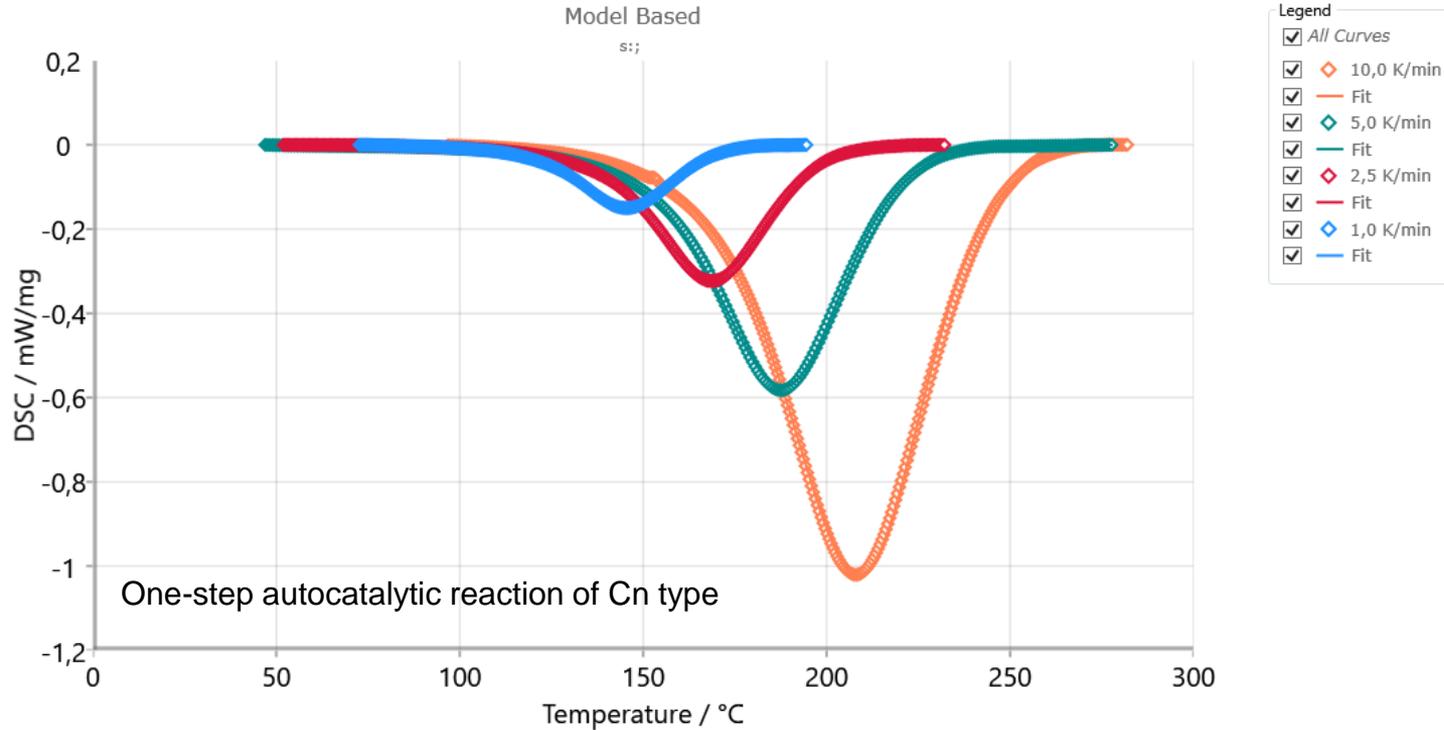
B_{na} – autocatalytical reaction of Prout-Tompkins

$$\frac{d\alpha}{dt} = A \cdot (1 - \alpha)^n \cdot \exp\left(\frac{-E_{a1}}{RT}\right) \cdot \alpha^m$$

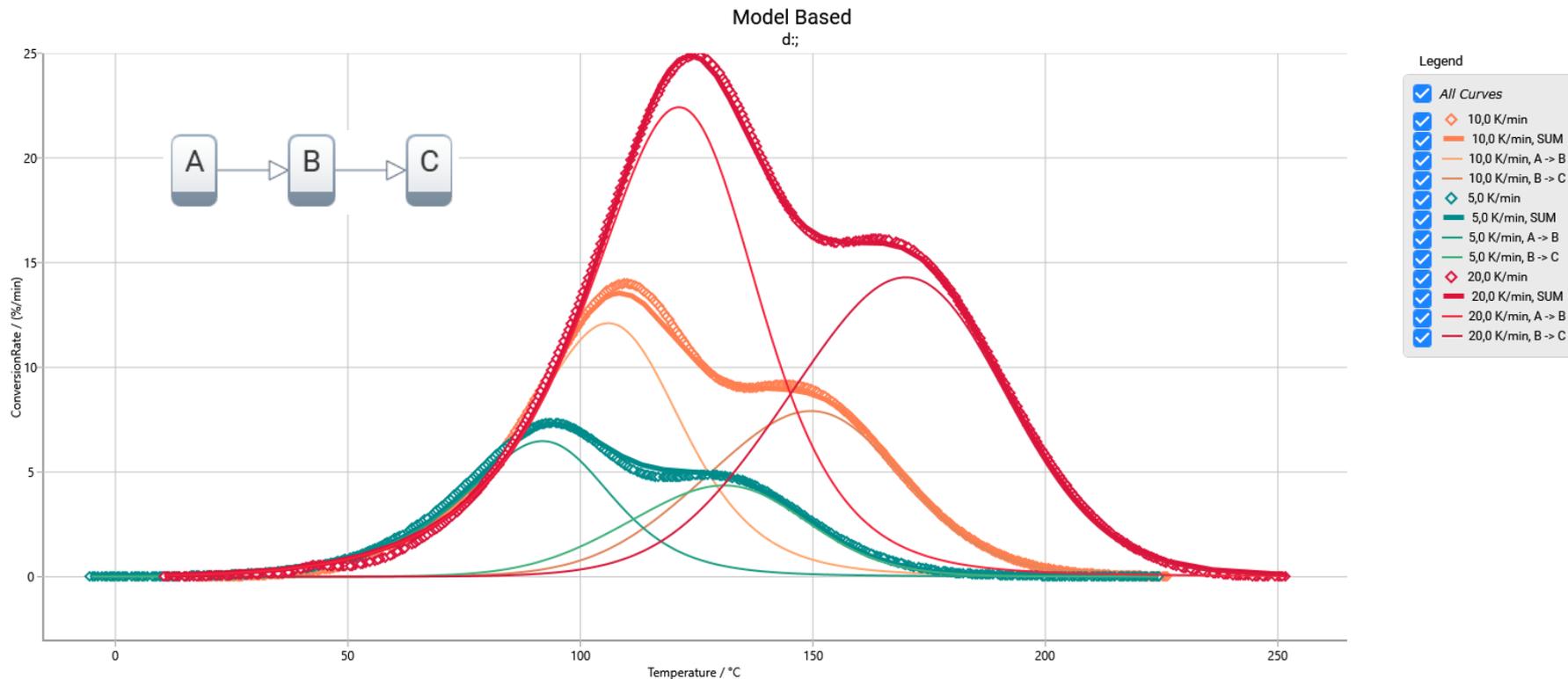


This **equation** with its parameters A , E_{a1} , n , E_{a2} , K , m , is the **kinetic model**.

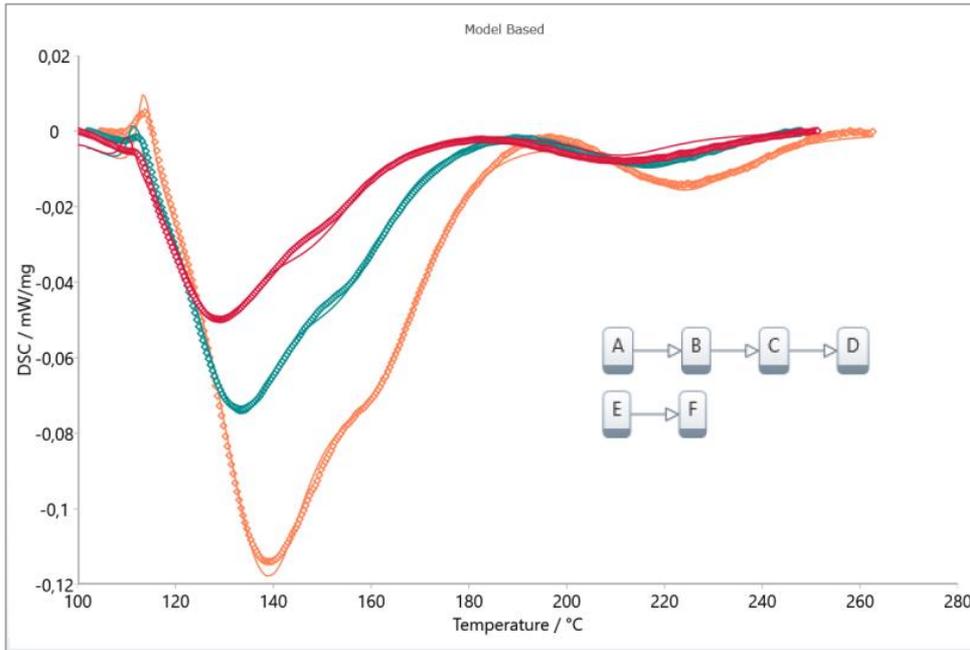
Autocatalytic model for mono-functional epoxy (phenyl glycidyl ether with aniline)



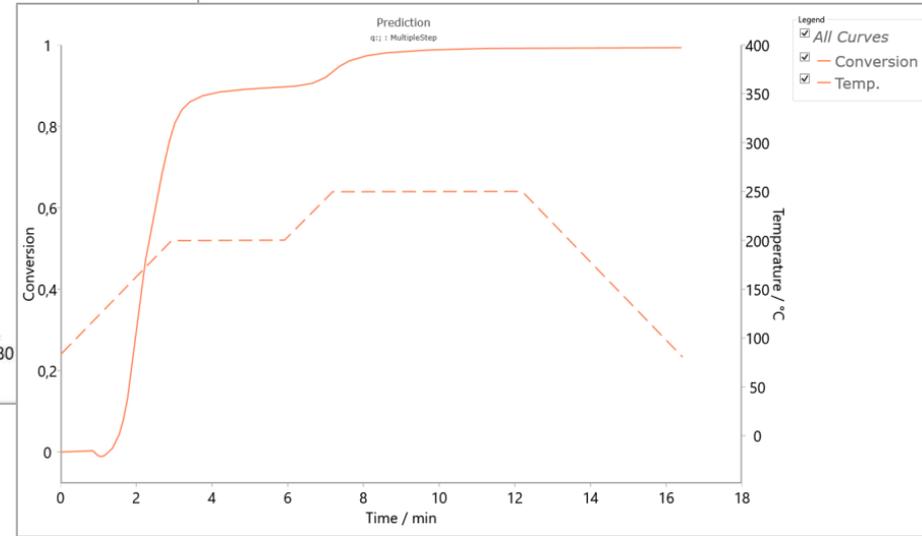
2-step Epoxy curing with two consecutive steps



DSC Measurement of a Phenol Formaldehyd Resin



DSC 214 *Polyma*
Sample: PF resin
Crucible: high-pressure
Sample mass: 20.24 mg
Temperature program: RT... 280°C, 5 K/min



Shear viscosity for Epoxy system (Rheology)

Properties

Data Preparation

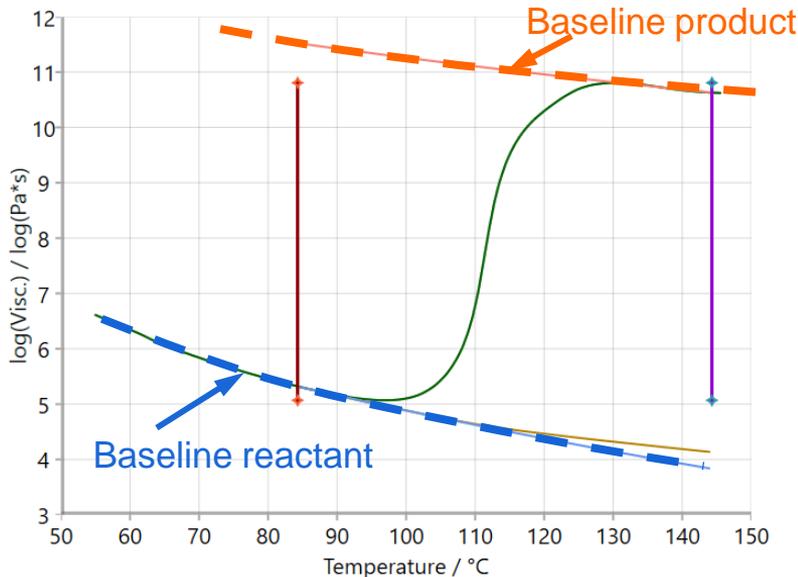
Range
 Left: 84,28 Right: 144,30

Smoothing

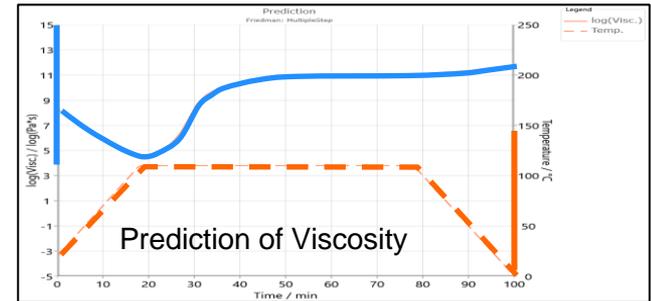
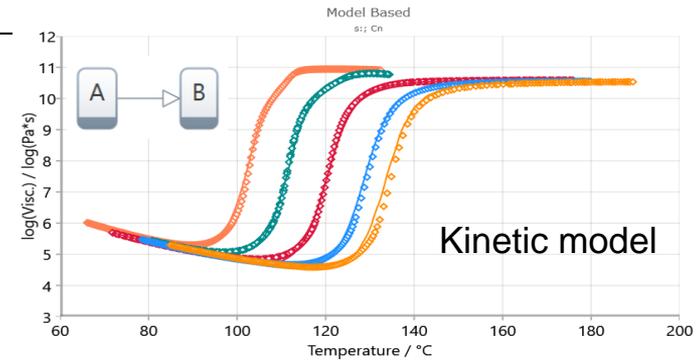
Baseline

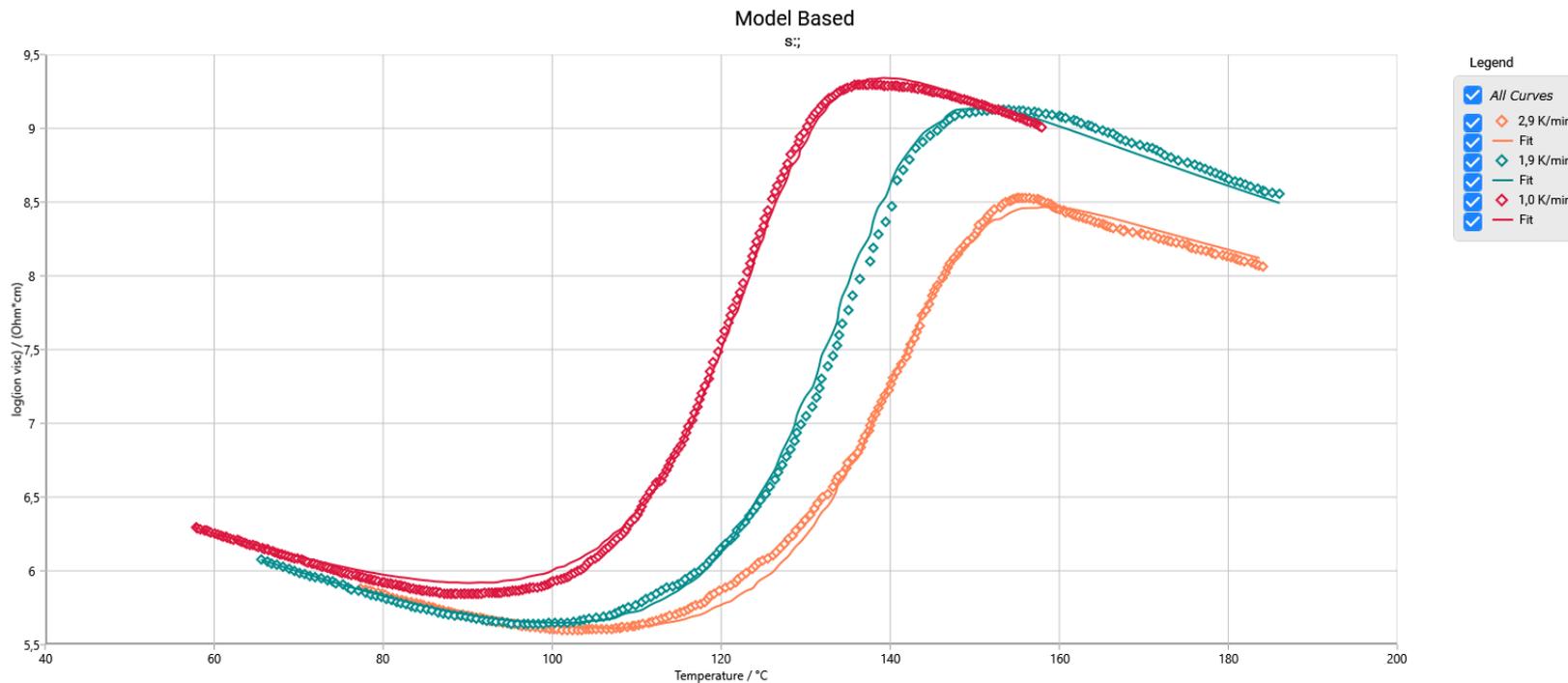
Show Additional Curve
 Temperature

Change of log(Visc.): 6,497 log(Pa*s)
 Heating Rate: 1,0 K/min



Tangential baseline for heating







Blacks S.r.l.

Headquarters: Faenza, Italy

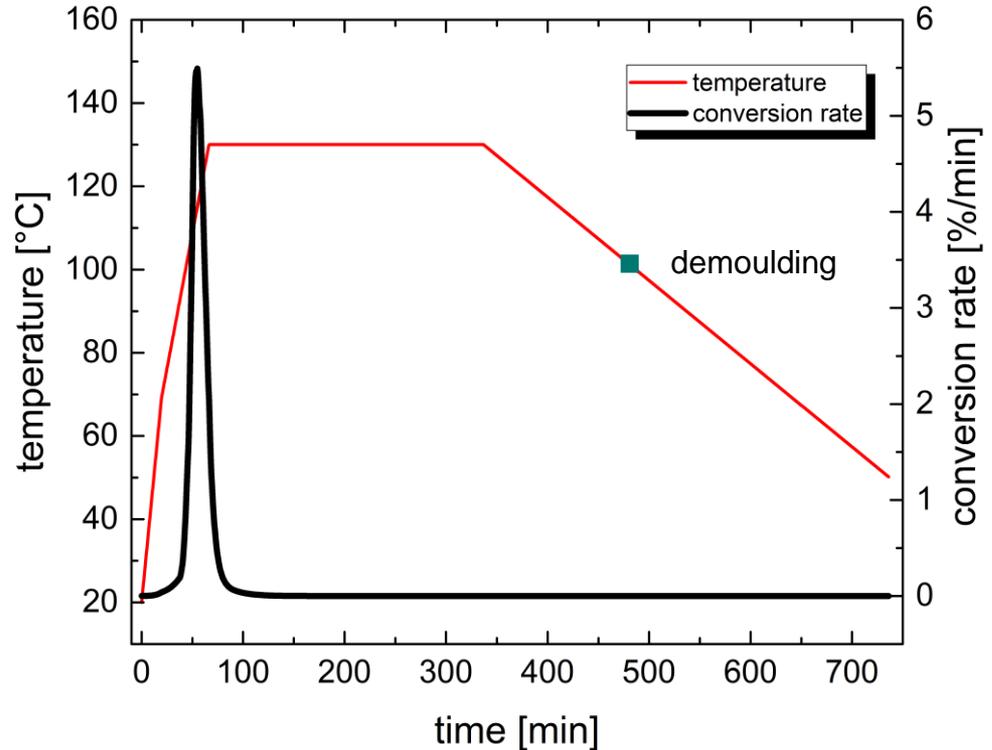
- Specialty: Design, prototyping and manufacture of advanced composite materials
- Carbon, glass, aramid, hybrid fibres
- Hand lay-up, autoclave curing
- Automotive, sporting goods, marine and aerospace sectors
- More information:

<http://www.blacks-composites.it>

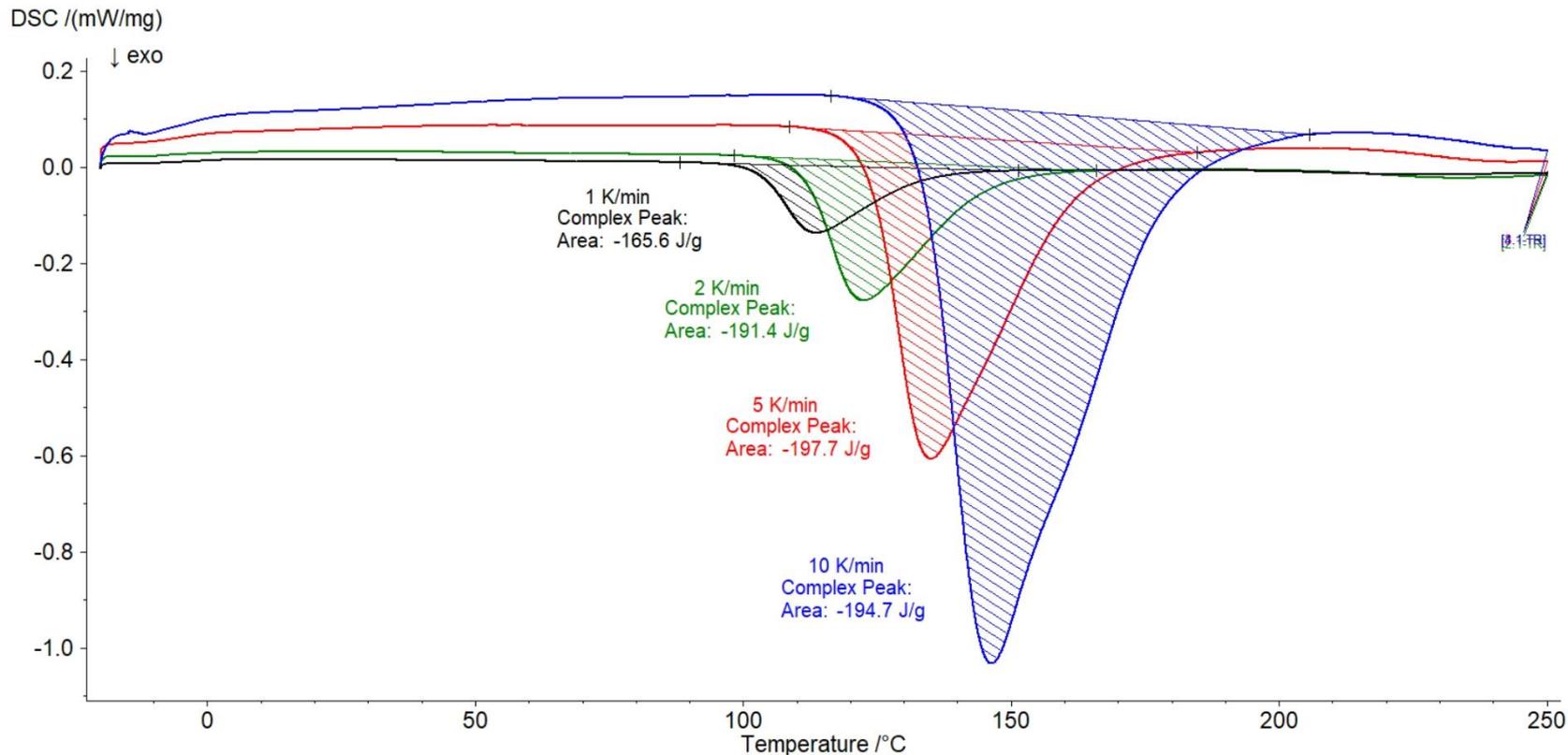
- Total cure cycle: 12 hours to reach required 95% conversion, based on material data sheet
- Existing cycle too long and needed optimisation
- Overheating of the material must be avoided due to the curing exotherm



Can the cycle be shortened with the same or a better part quality?

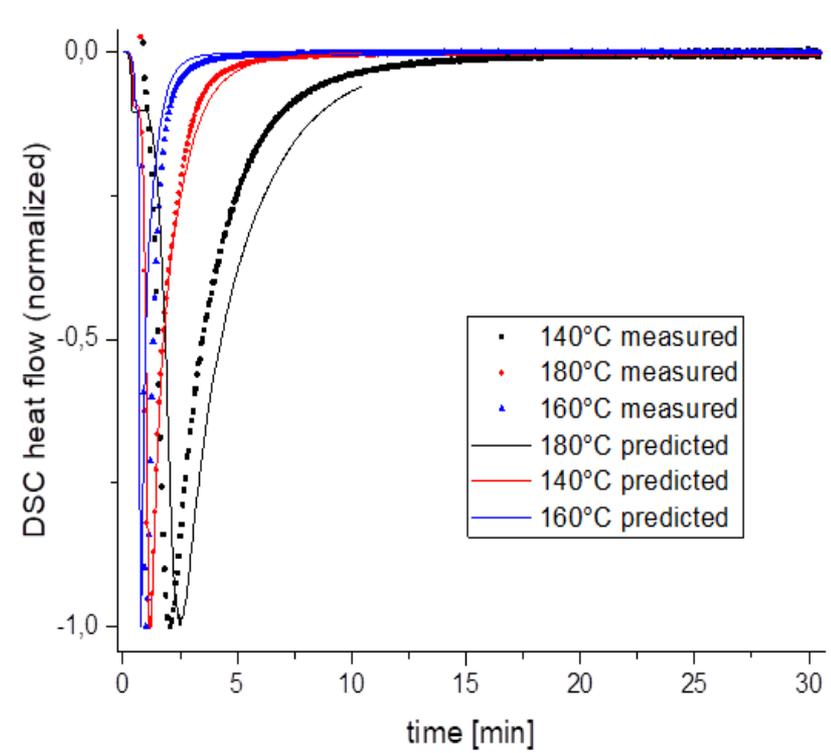
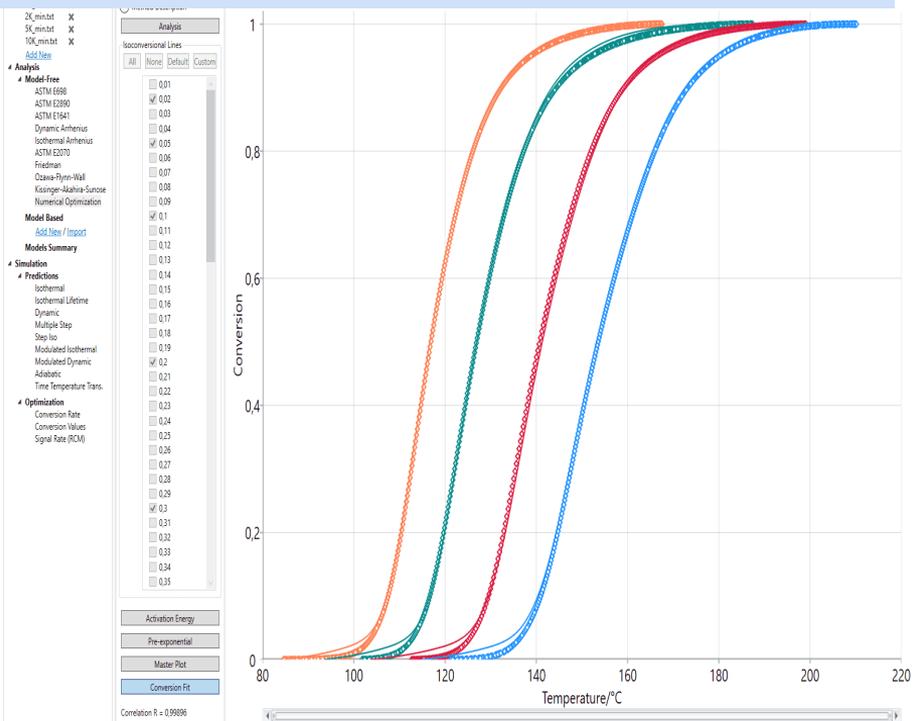


Step 2 - Kinetic Analysis of CFRP Prepreg @ 4 heating rates

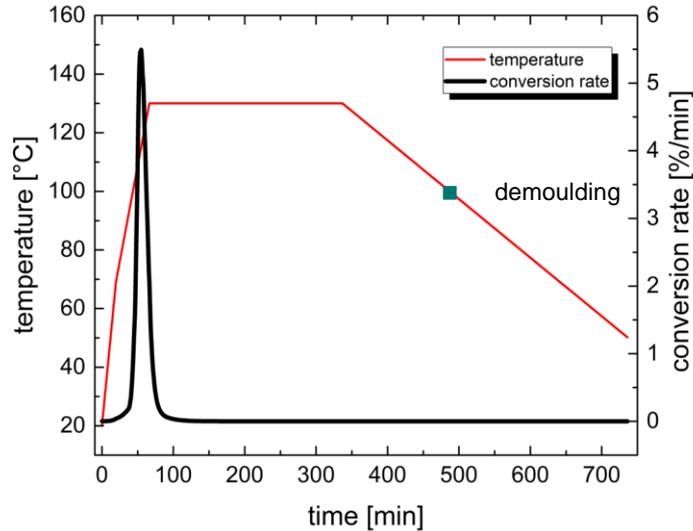


‘Numerical Optimisation’ Provides Easy One Click Solution – $R^2=0.99896$

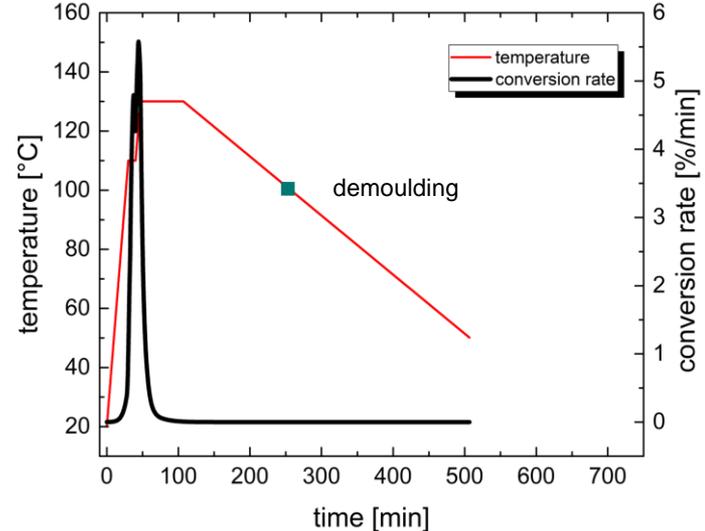
Model Validation at isothermal conditions



Conventional Cycle

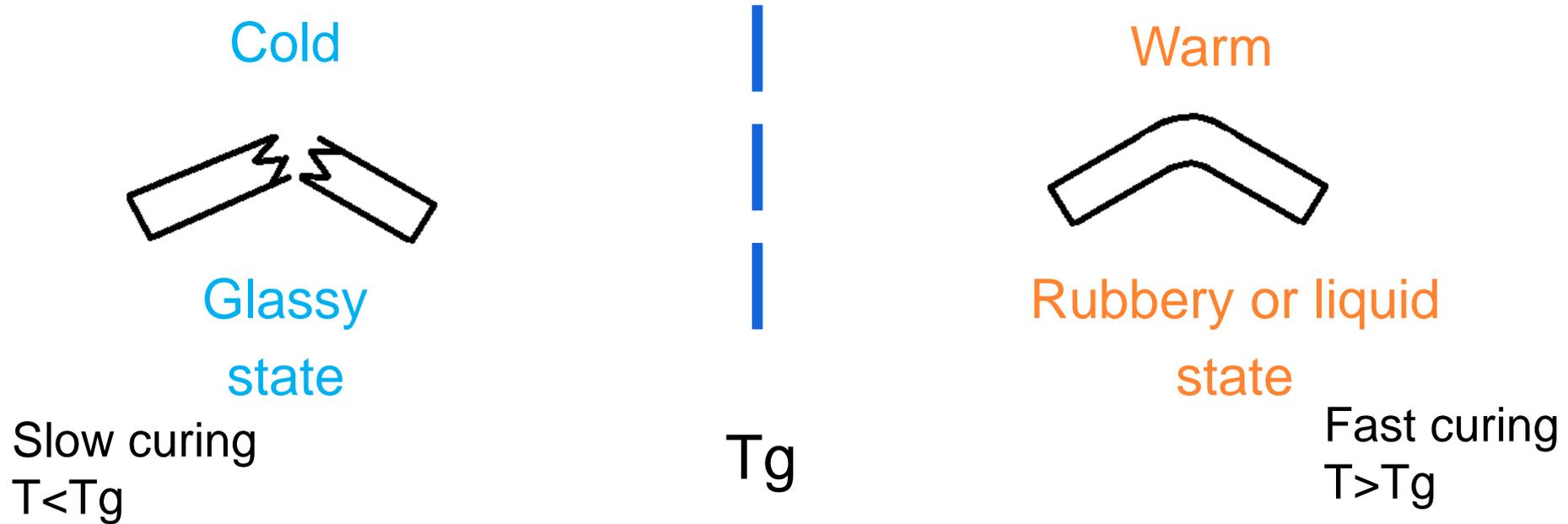


New Cycle



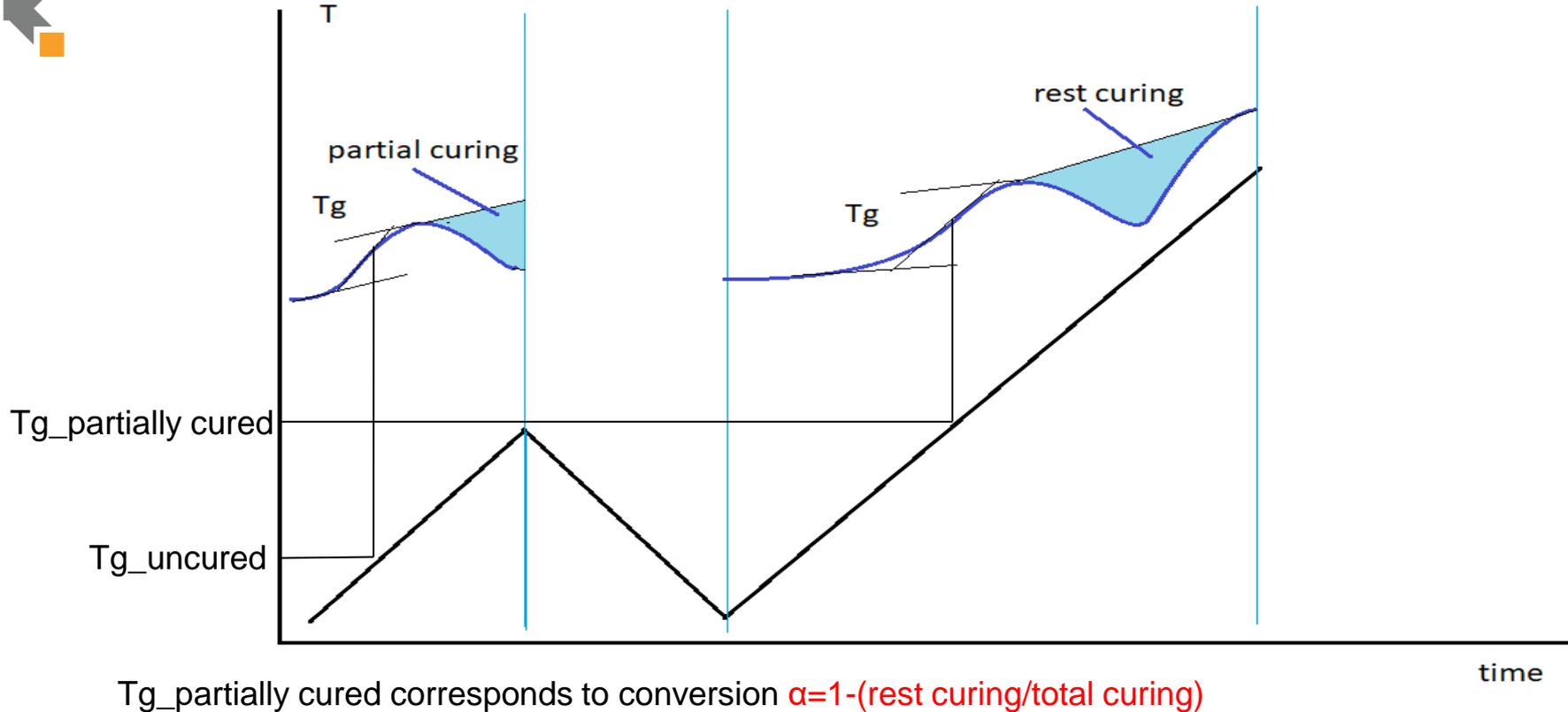
- Maximum conversion rate of new cycle does not exceed conventional cycle

Production time reduced from 460 to 280 minutes



Glass transition increases with degree of cure

Determination of glass transition Temperature for partially cured material



[M]acro- molecular Theory and Simulations

Research Article

Time-Temperature-Transformation (TTT) Cure Diagram of an Epoxy-Amine System

Claire Strasser, Elena Moukhina, Jürgen Hartmann

First published: 15 June 2024 | <https://doi.org/10.1002/mats.202400039>

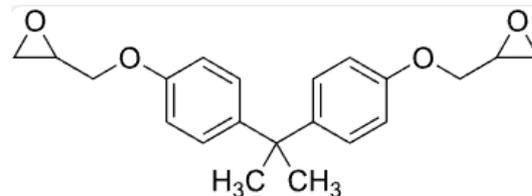
[Read the full text >](#)

 PDF  TOOLS  SHARE

Abstract

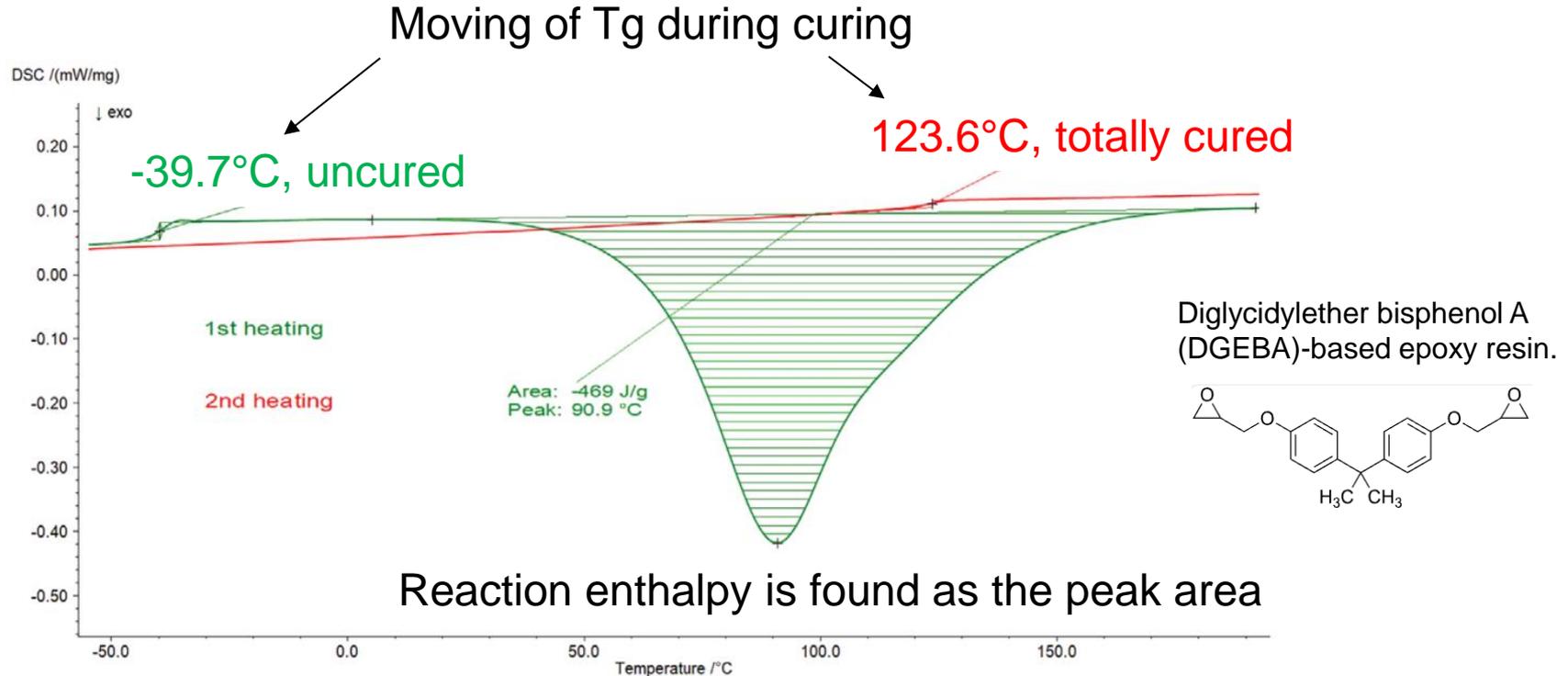
A time-temperature-transformation diagram is created for the curing reaction of a diglycidylether bisphenol A (DGEBA)-based epoxy resin. It results from a kinetic analysis performed by means of dynamical differential scanning calorimetry (DSC) measurements; a gelation curve determined with isothermal and dynamical rheological tests; and a vitrification curve obtained from temperature-modulated dynamic DSC measurements. The resulting diagram is validated by comparison of isothermal measurements with the corresponding calculated curves.

Diglycidylether bisphenol A (DGEBA)-based epoxy resin.



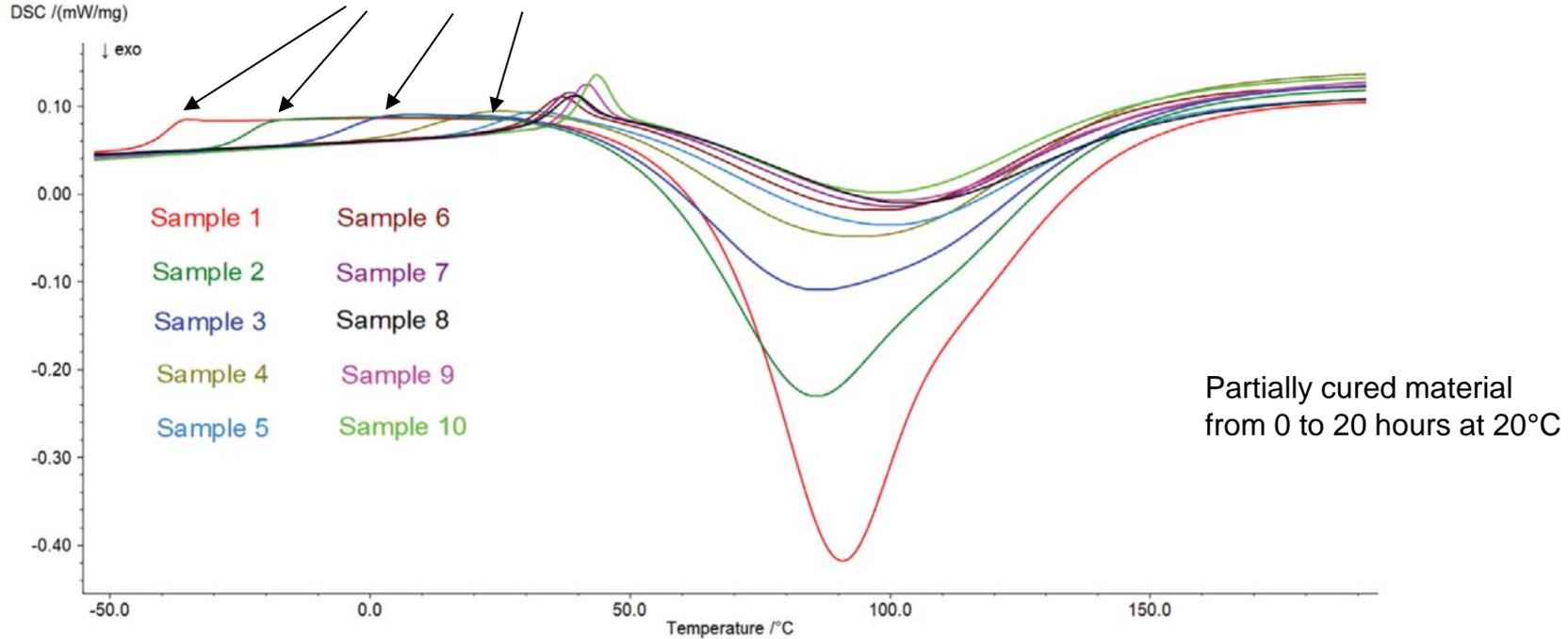
a hardener (e.g., amine) is mixed to the epoxy monomer and this mixture is introduced into a mold containing (or not) a reinforcement.

Measurements Step1: enthalpy and glass transition (DSC) for original material

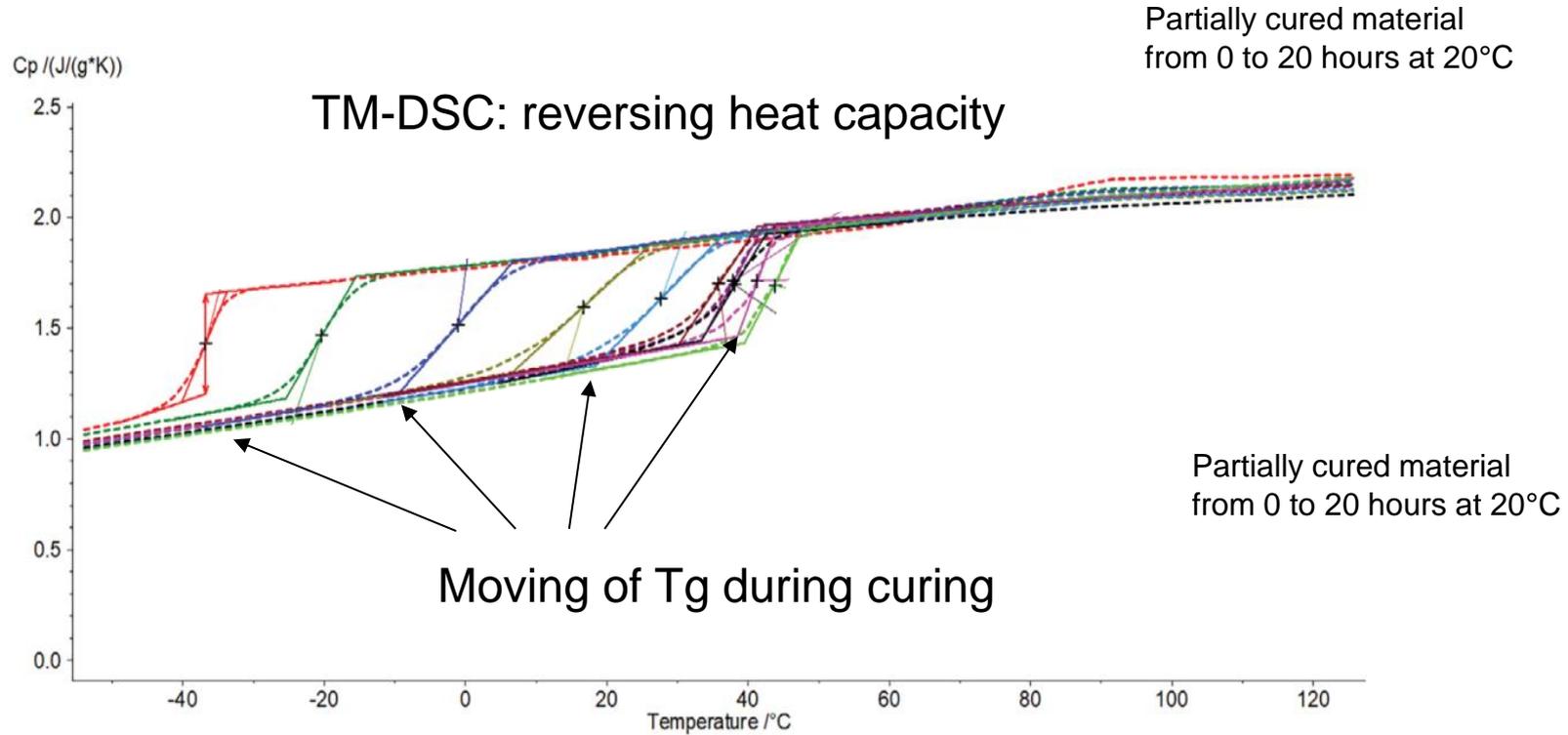


Measurements Step2: enthalpy and glass transition (DSC) for partially cured material

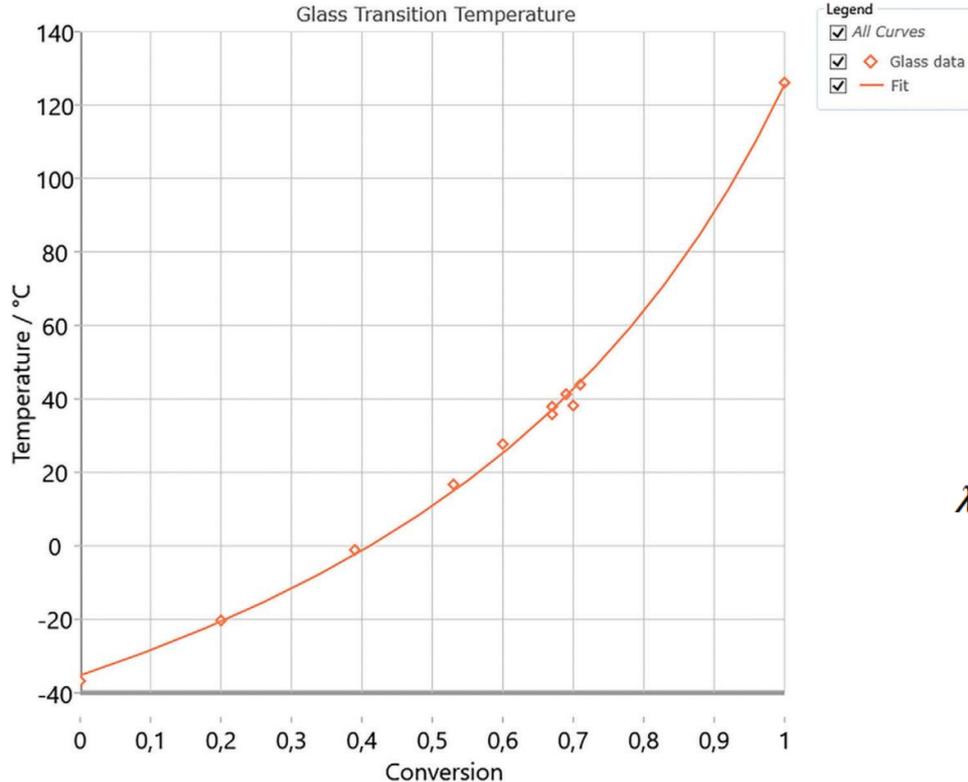
Moving of Tg during curing



Measurements Step3: enthalpy and glass transition (TM-DSC) for partially cured material



Reversing C_p (specific heat capacity) for the samples with different degrees of cure, $3 K min^{-1}$



Di Benedetto equation

$$\frac{T_g - T_{g0}}{T_{g\infty} - T_{g0}} = \frac{\lambda \alpha}{1 - (1 - \lambda) \alpha}$$

$$\lambda = \frac{\Delta C_p (\text{fully cured material})}{\Delta C_p (\text{fully uncured material})} = 0.4$$

$$\frac{d\alpha}{dt} = k(T) \cdot f(\alpha) \quad f(\alpha): \text{Kamal-Sourour}$$

Chemical rate (slow):

$$T_{\text{material}} \ll T_g$$

$$k(T) = A \cdot \exp\left(-\frac{E}{RT}\right)$$

Low Pre-exponent A

Diffusion controlled rate

$$T_g < T_{\text{material}} < T_g + 100$$

$$\frac{1}{k} = \frac{1}{k_D} + \frac{1}{k_{\text{chem}}}$$

$$k(T) = k_{\text{chem}} = A \cdot \exp\left(-\frac{E}{RT}\right)$$

Williams-Landel-Ferry:

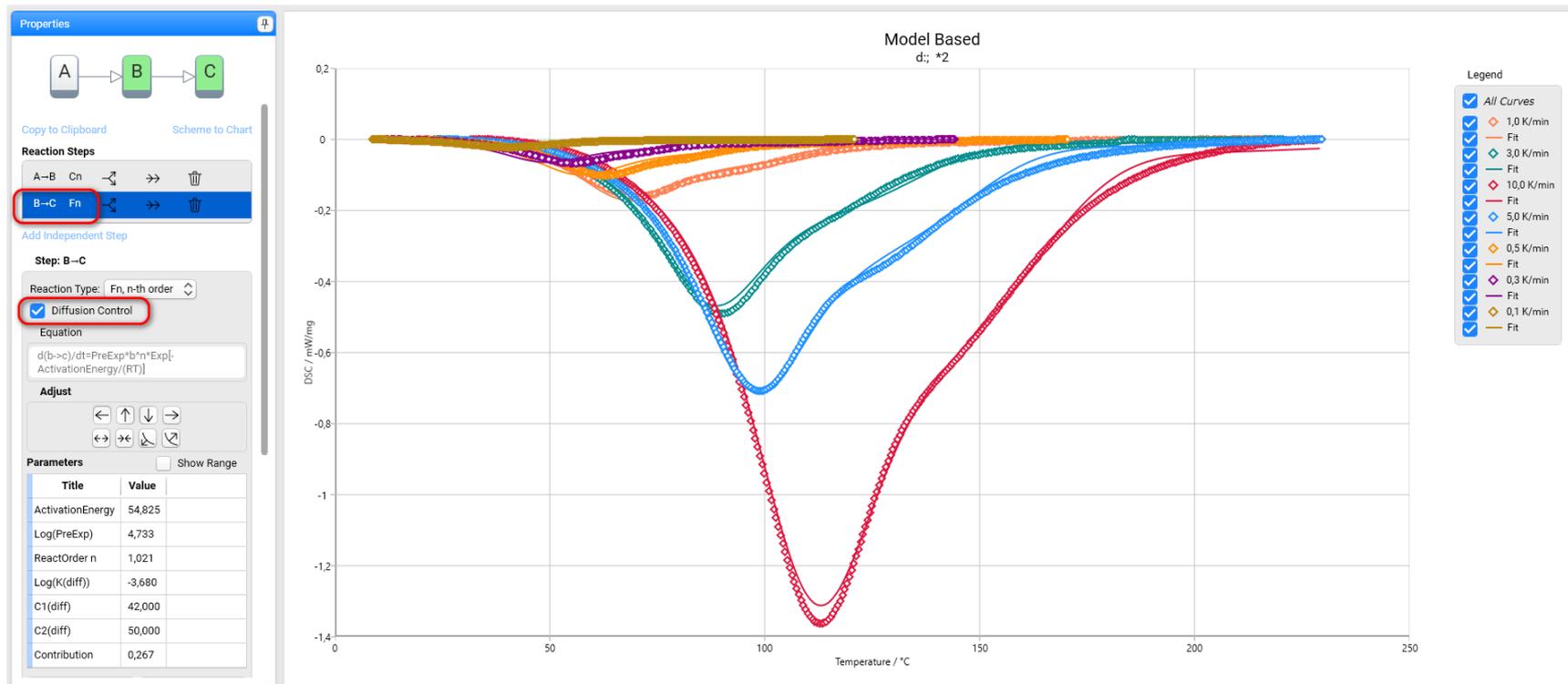
$$k_D(\alpha, T) = D_0 \exp\left[\frac{C_1 (T - T_g(\alpha))}{C_2 + T - T_g(\alpha)}\right]$$

Chemical rate (fast):

$$T_{\text{material}} \gg T_g$$

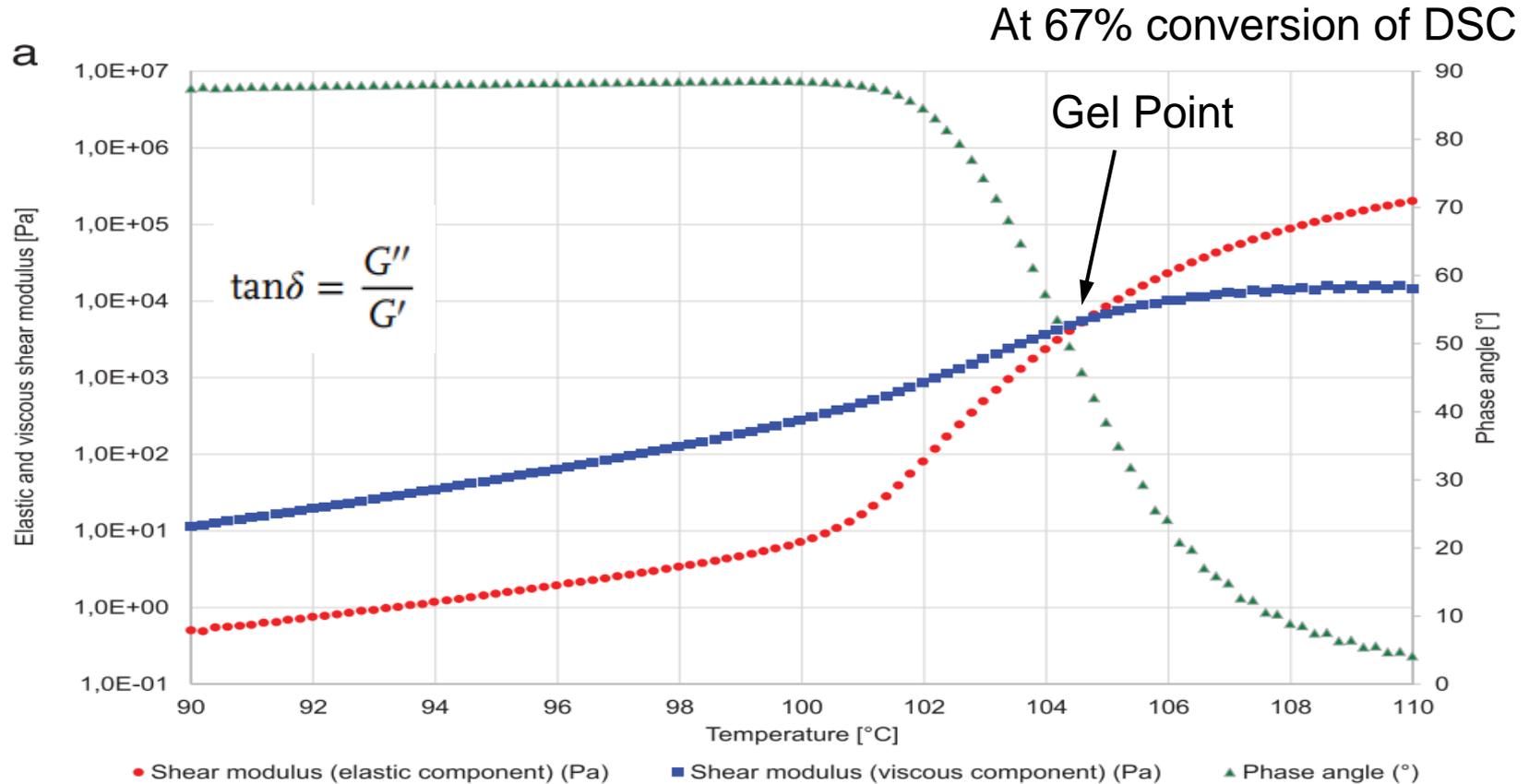
$$k(T) = A \cdot \exp\left(-\frac{E}{RT}\right)$$

High Pre-exponent A



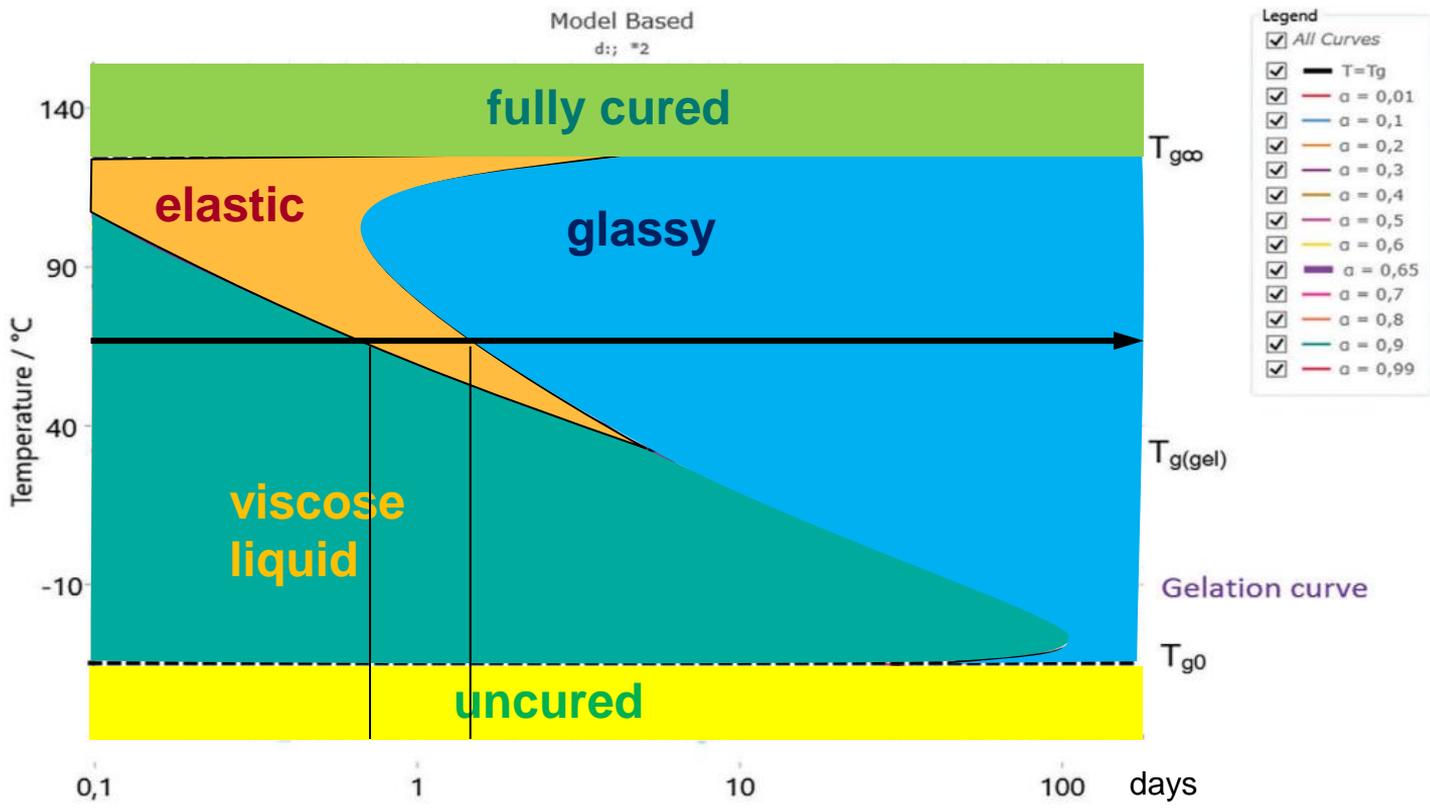
Diffusion control can be switch ON/OFF for each reaction step

Measurements Step4: Gel point (Rheology) for original material

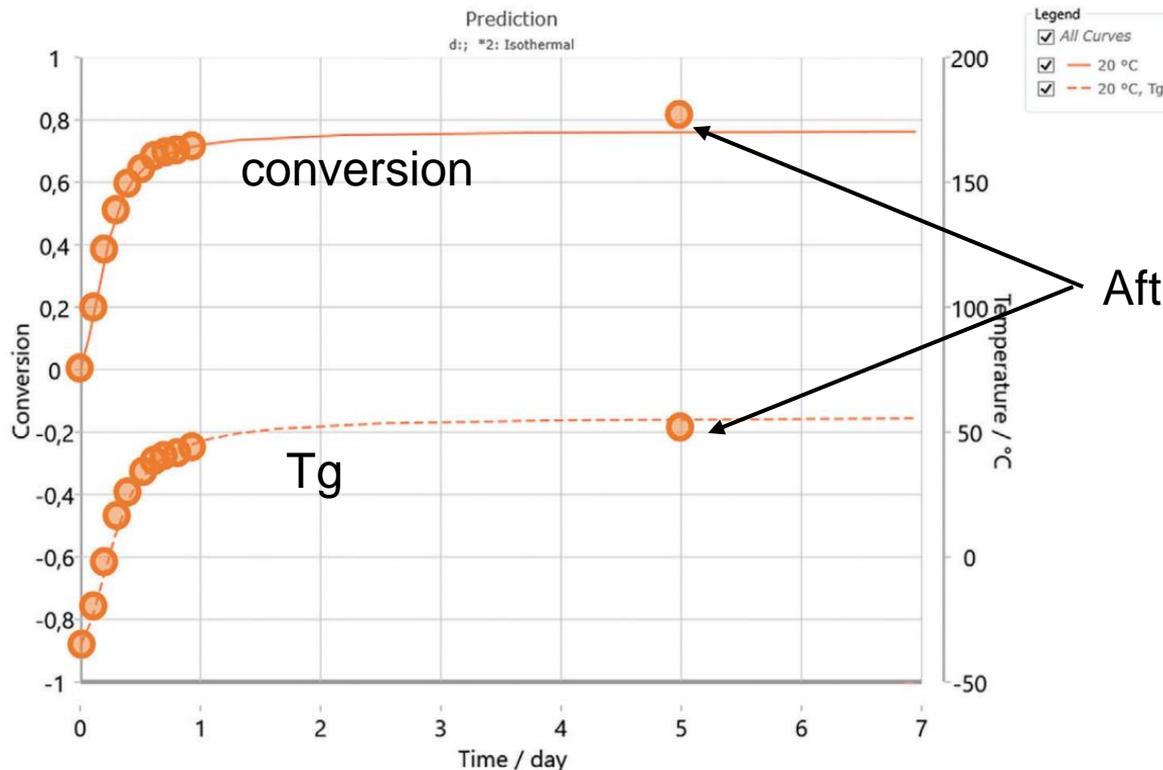


Project [icon]

- Source Data
 - Add New
- Glass Transition Data
- Analysis
 - Simulation**
 - Predictions**
 - Isothermal
 - Isothermal Lifetime
 - Dynamic
 - Multiple Step
 - Step Iso
 - Modulated Isothermal
 - Modulated Dynamic
 - Adiabatic
 - Adiabatic24
 - Climatic
 - Time Temperature Trans.**
 - External Temp. Profile
- Optimization

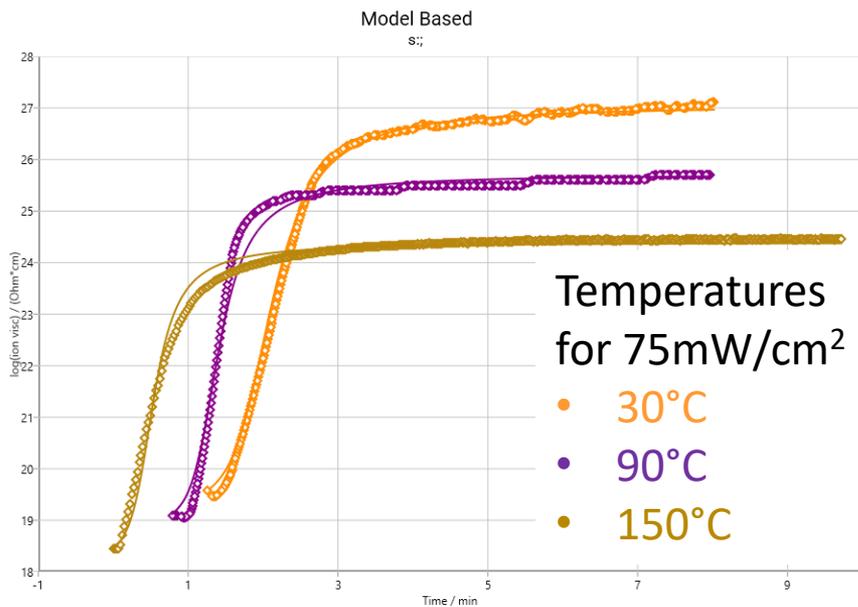


TTT diagram of the investigated epoxy resin

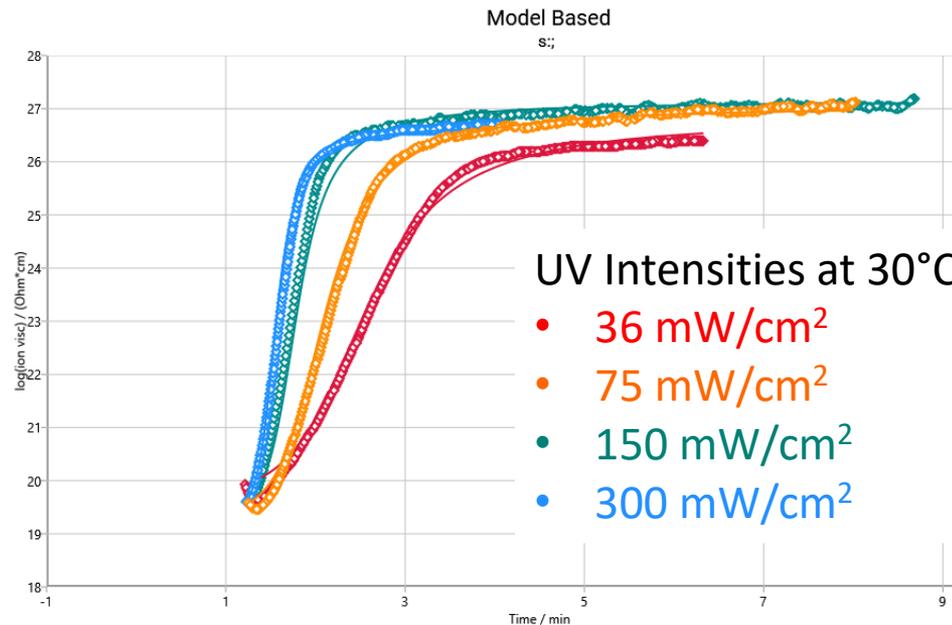


Prediction of Kinetics Neo for curing at room temperature

3. Dependence on additional parameter

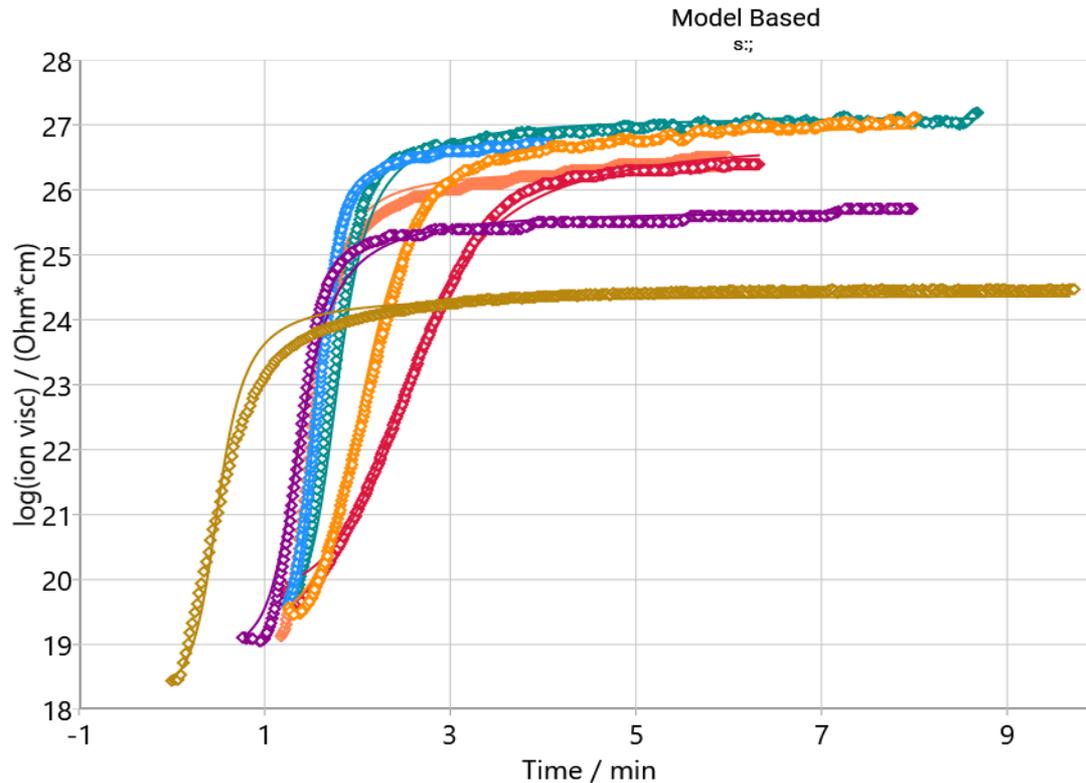


Isothermal DEA measurements at 30°C , 90°C , 150°C for light exposure at $75\text{mW}/\text{cm}^2$



Isothermal DEA measurements at 30°C for light exposure at different intensities from $75\text{mW}/\text{cm}^2$ to $150\text{mW}/\text{cm}^2$

depending on both temperature and the intensity of UV light



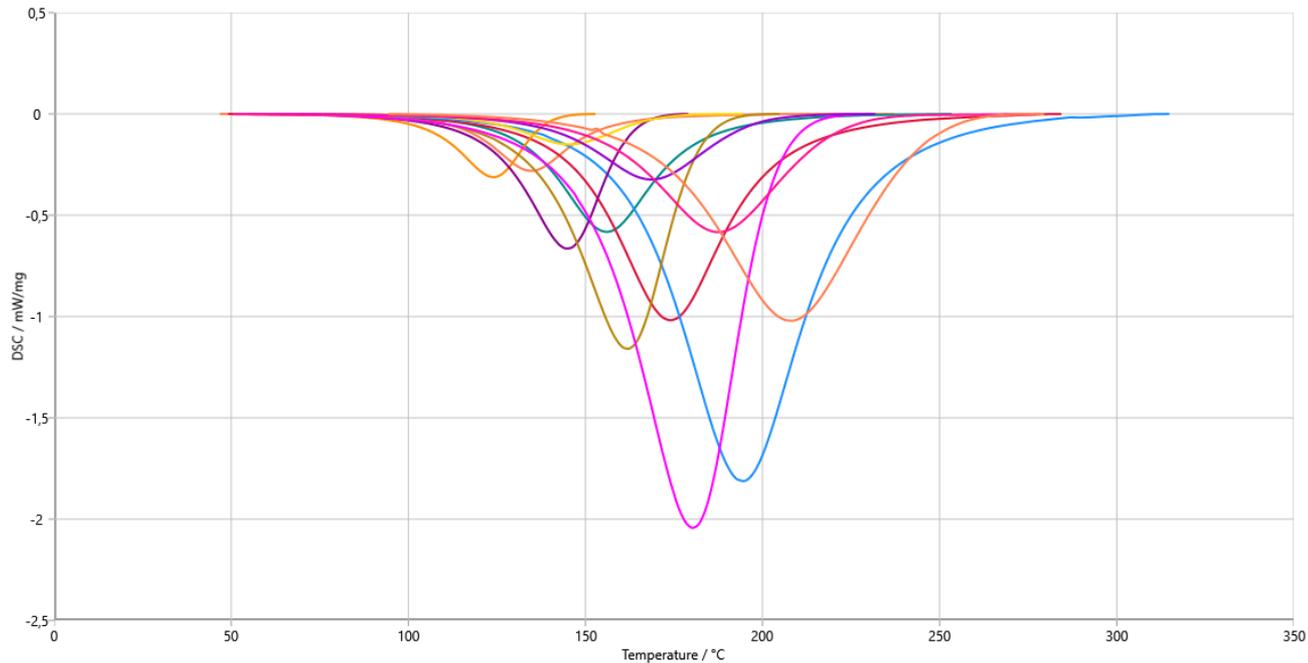
Temperatures

- 30°C
- 90°C
- 150°C

UV Intensities

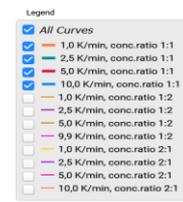
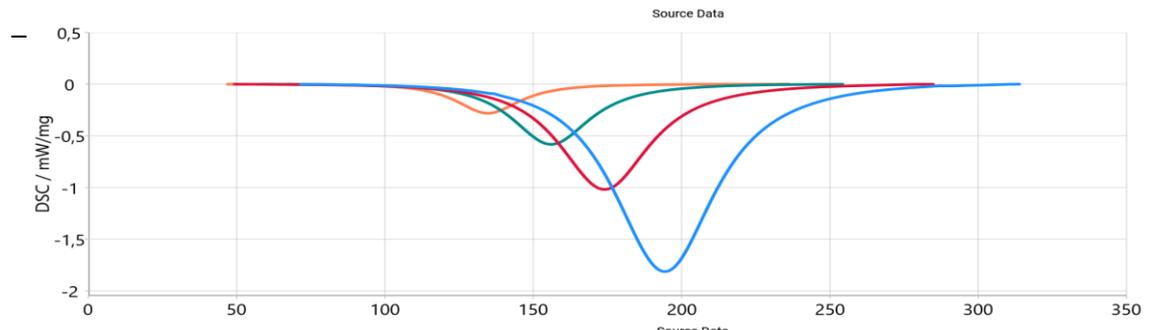
- 36mW/cm²
- 75mW/cm²
- 150mW/cm²
- 300mW/cm²

Source Data

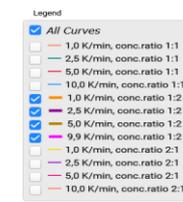
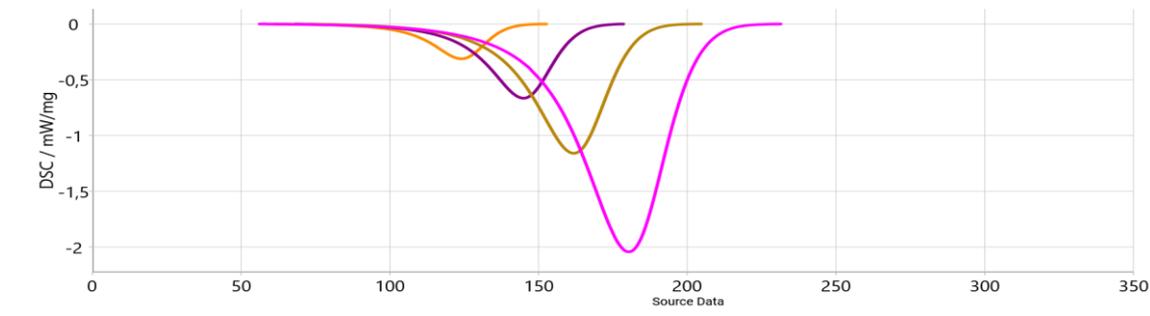


- Legend
- All Curves
 - 1,0 K/min, conc.ratio 1:1
 - 2,5 K/min, conc.ratio 1:1
 - 5,0 K/min, conc.ratio 1:1
 - 10,0 K/min, conc.ratio 1:1
 - 1,0 K/min, conc.ratio 1:2
 - 2,5 K/min, conc.ratio 1:2
 - 5,0 K/min, conc.ratio 1:2
 - 9,9 K/min, conc.ratio 1:2
 - 1,0 K/min, conc.ratio 2:1
 - 2,5 K/min, conc.ratio 2:1
 - 5,0 K/min, conc.ratio 2:1
 - 10,0 K/min, conc.ratio 2:1

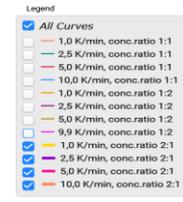
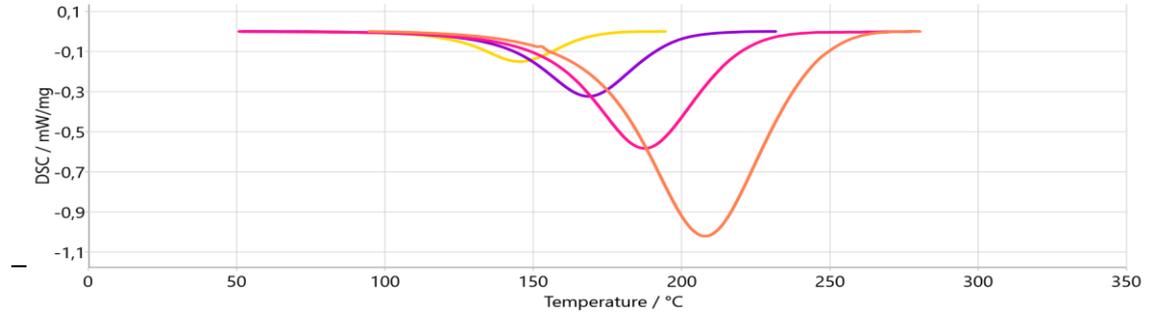
Peak position for different concentrations



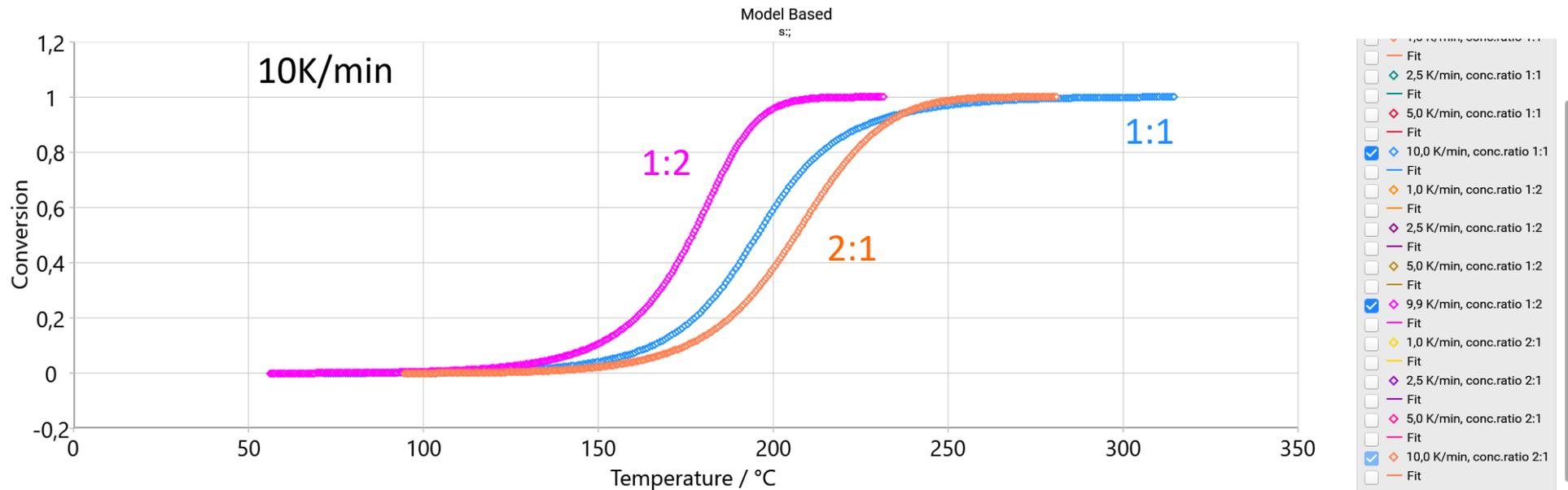
Epoxy/Aniline 1:1
Peak 10K/min 194°C



Epoxy/Aniline 1:2
Peak 10K/min 180°C



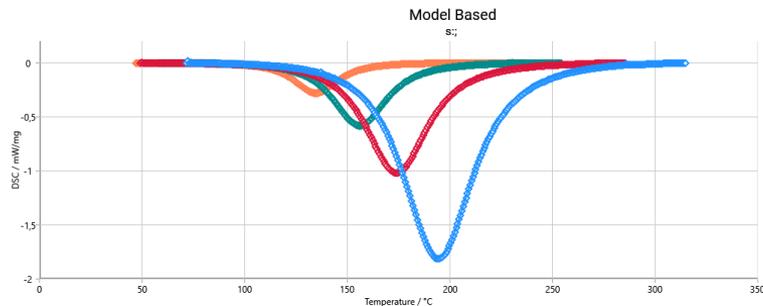
Epoxy/Aniline 2:1
Peak 10K/min 207°C



Independent kinetic analysis for each concentration ratio

Parameters Show Range

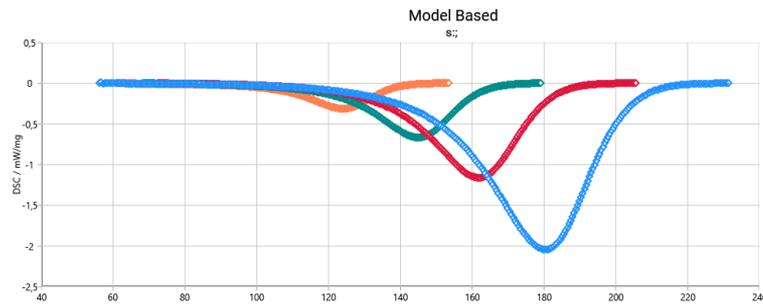
Title	Value
ActivationEnergy	53,583
Log(PreExp)	2,931
ReactOrder n	1,806
Log(AutocatPreExp)	1,389
Contribution	1,000



Epoxy/Aniline 1:1
 $\log A = 2.9$
 $n = 1.8$

Parameters Show Range

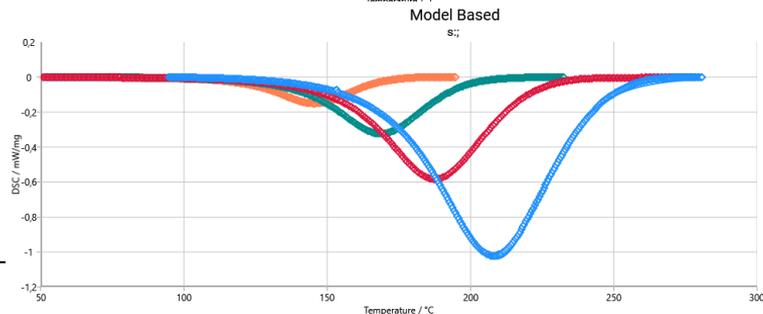
Title	Value
ActivationEnergy	54,148
Log(PreExp)	3,368
ReactOrder n	1,108
Log(AutocatPreExp)	1,142
Contribution	1,000



Epoxy/Aniline 1:2
 $\log A = 3.3$
 $n = 1.1$

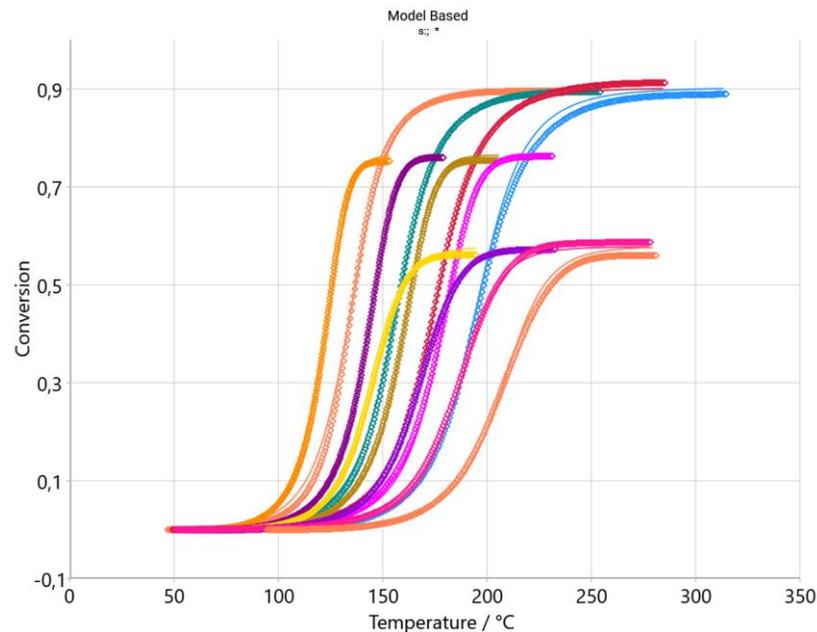
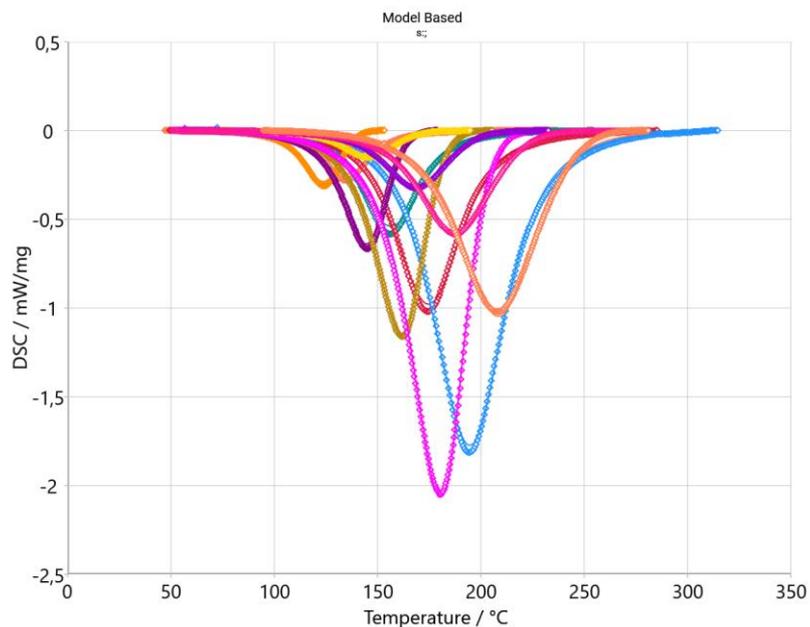
Parameters Show Range

Title	Value
ActivationEnergy	54,258
Log(PreExp)	3,015
ReactOrder n	1,398
Log(AutocatPreExp)	1,068
Contribution	1,000



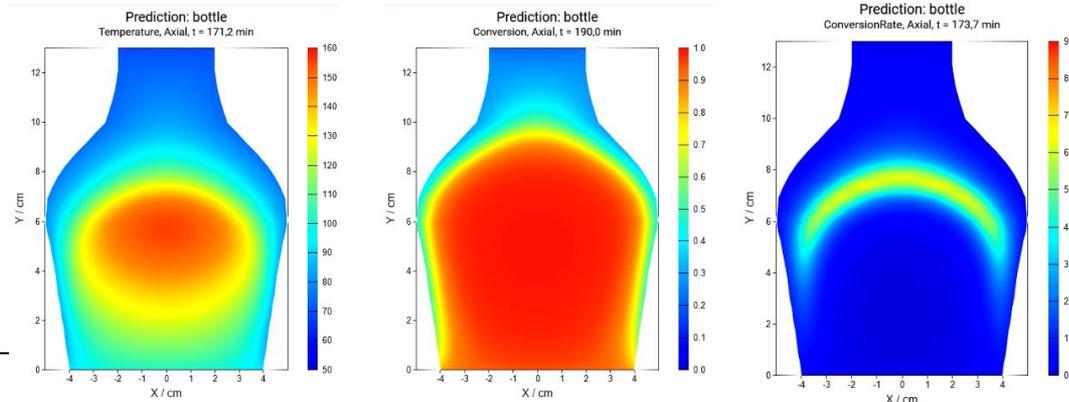
Epoxy/Aniline 2:1
 $\log A = 3.0$
 $n = 1.0$

Kinetics Neo: common kinetic model for all concentration ratios and all heating rates



5

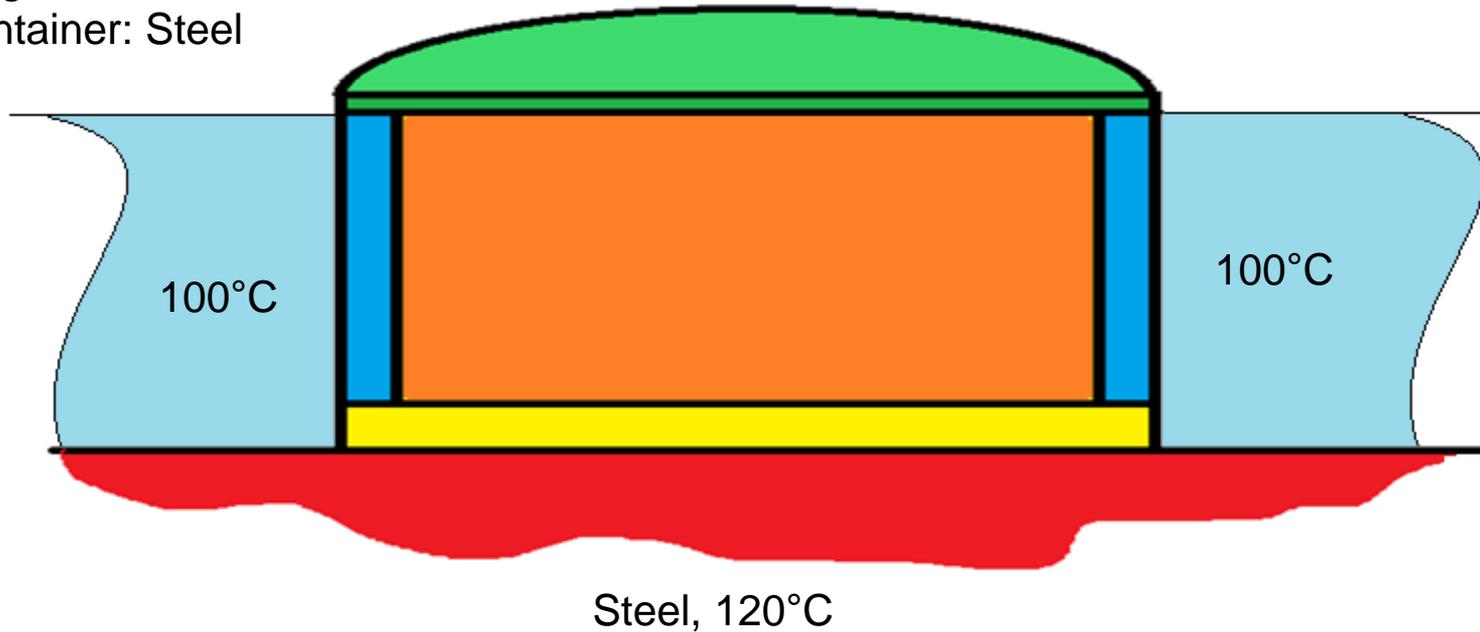
Simulation and optimization for thick layers Dependence on thickness and surrounding Termica Neo software



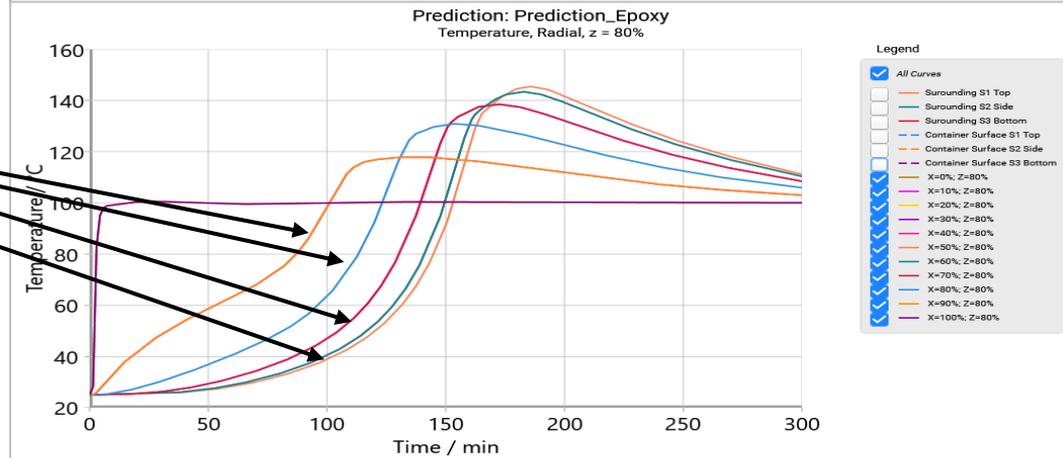
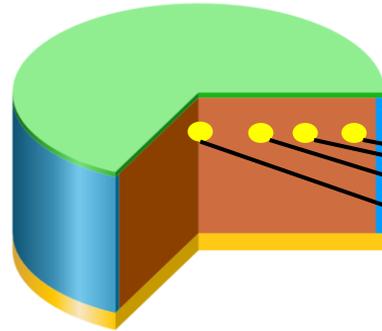
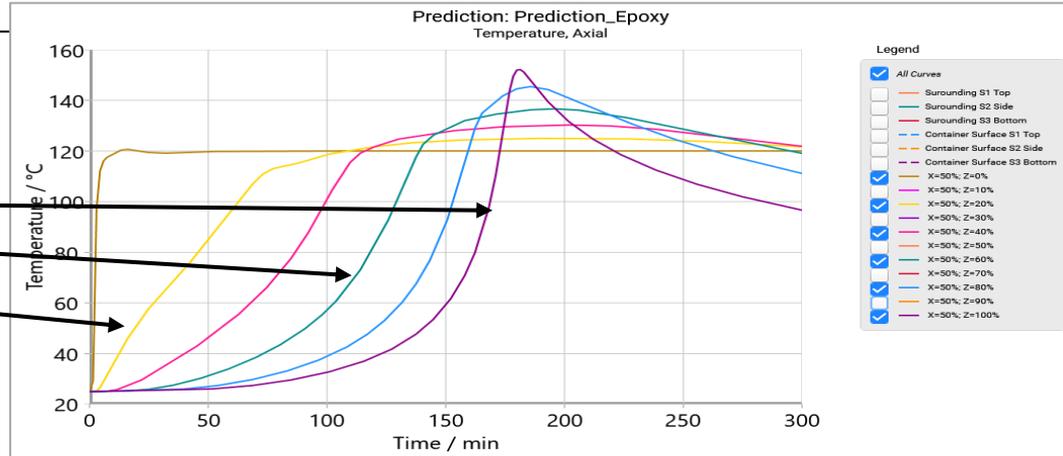
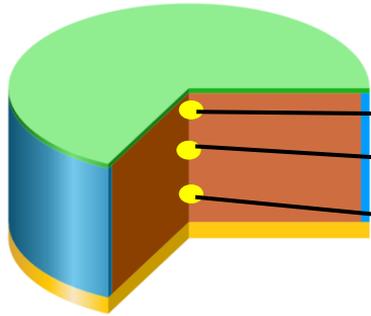
Simplest example for epoxy curing: Is the curing reaction complete after 2 hours?

Radius = 10 cm
Height = 8 cm
Container: Steel

Air, 25°C



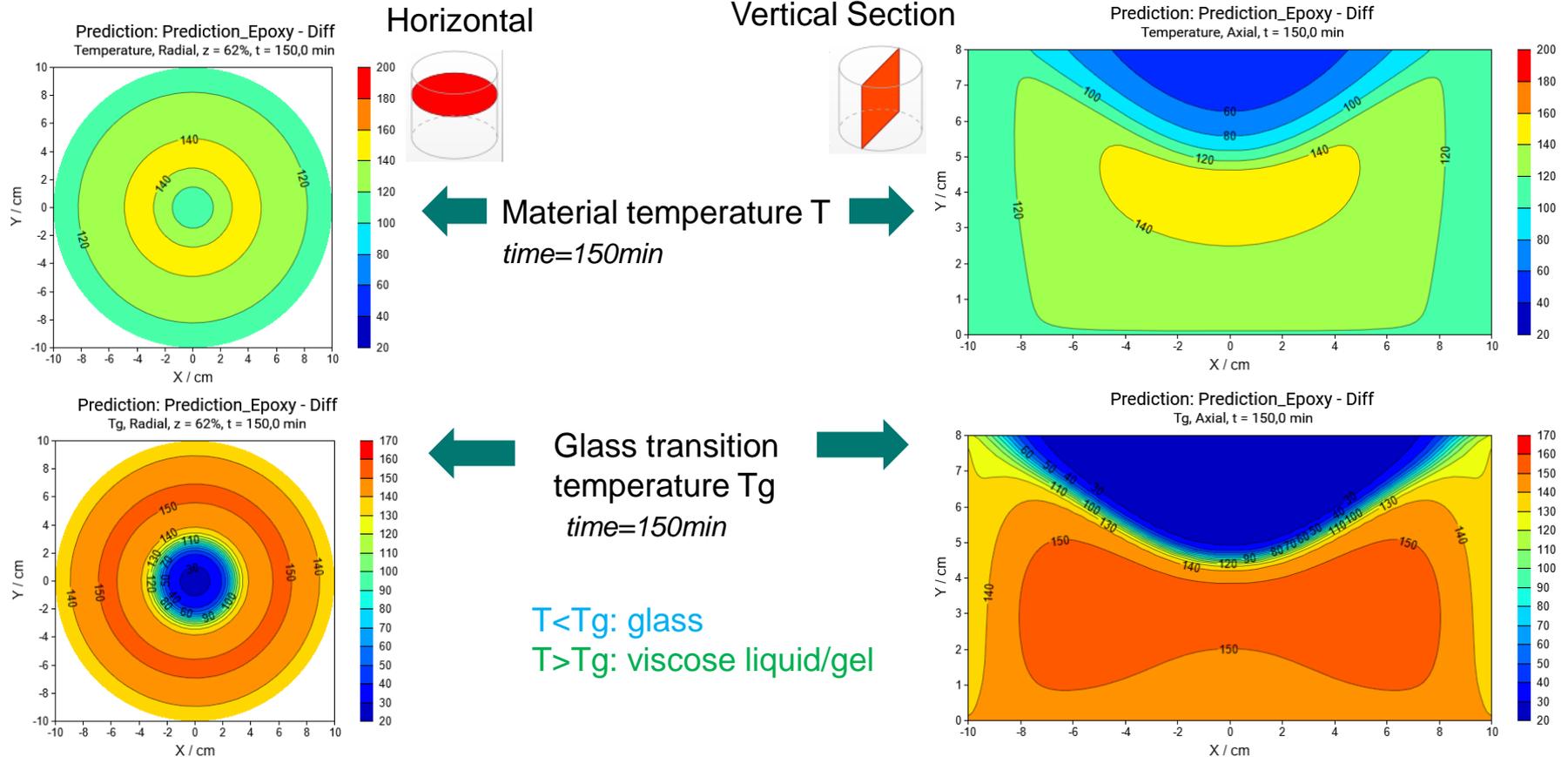
Results: Temperature vs time at any point of the reacting volume: Vertical or horizontal



Possible to show: Temperature, conversion, conversion rate, concentrations vs time

Simulation Example: Find Tg during Curing of epoxy

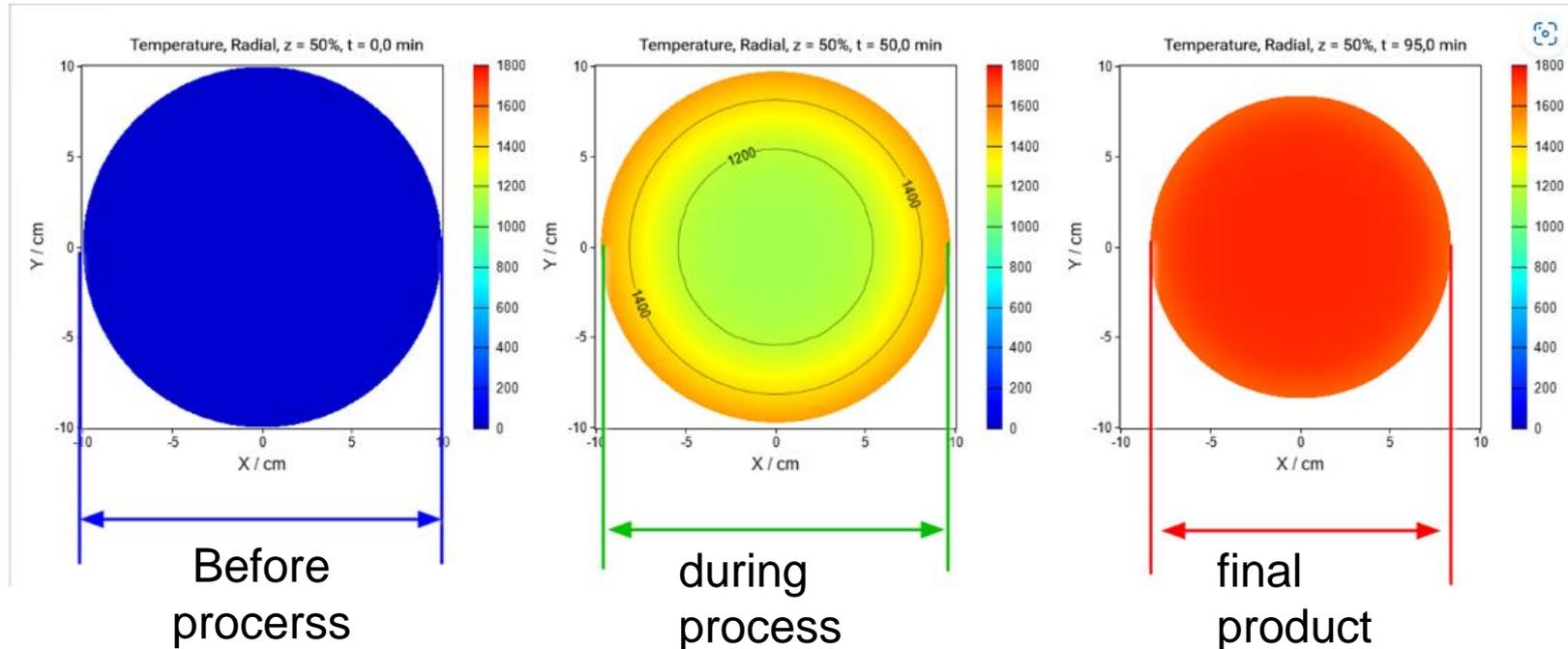
Horizontal and vertical cross-sections for cylinder



Simulation Example: changing of length

Reasons for linear changes:

1. thermal expansion
2. different density properties for reactant and final product (here)

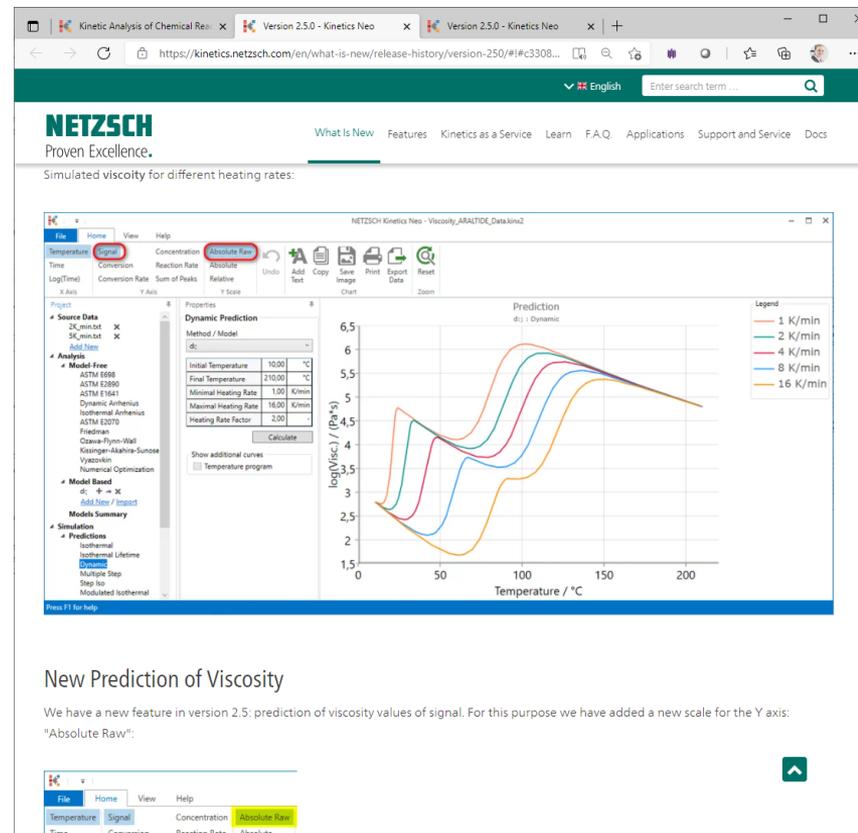
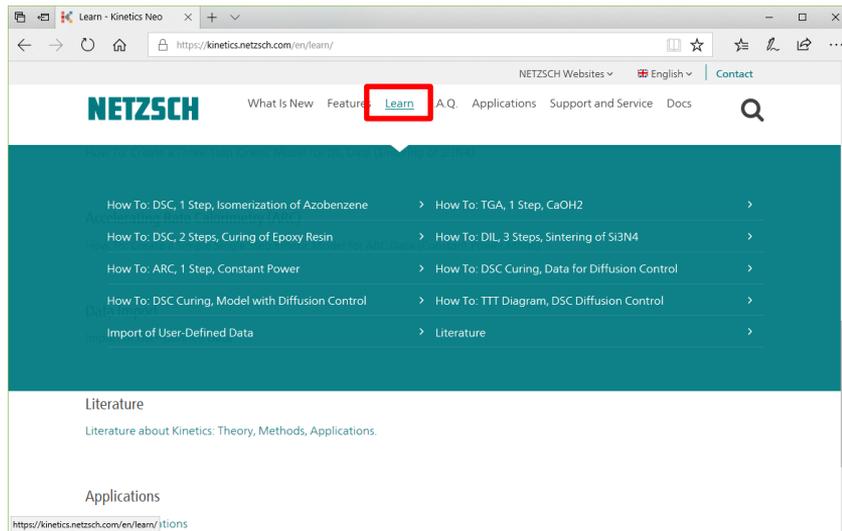


Users Guide, Training examples,

Webinars: (pdf and video):

- *Advantages and disadvantages of different kinetics approaches.*
- *Unique and powerful features of NETZSCH Kinetics Neo software*
- *Crystallization*
- *Polymers*

Trial Version 30 days



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Review

ICTAC Kinetics Committee recommendations for analysis of multi-step kinetics

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ABSTRACT

The present recommendations have been developed by the Kinetics Committee of the International Confederation for Thermal Analysis and Calorimetry (ICTAC). The recommendations provide guidance on kinetic analysis of multi-step processes as measured by thermal analysis methods such as thermogravimetry (TGA) and differential scanning calorimetry (DSC). Ways of detecting the multi-step kinetics are discussed first. Then, four different approaches to evaluation of kinetic parameters (the activation energy, the pre-exponential factor, and the reaction model) for individual steps are considered. The approaches considered include multi-step model-fitting as well as distributed reactivity, isoconversional, and deconvolution analyses. For each approach practical advice is offered on its effective usage. Due attention is also paid to the typical problems encountered and to the ways of resolving them. The objective of these recommendations is to help a non-expert with efficiently performing multi-step kinetic analysis and interpreting its results.

- Model free analysis
- Multi-step model-fitting (model based)
- Diffusion control for curing
- Crystallization kinetics
- Kamal model for curing
- Deconvolution analysis (sum of peaks)

